

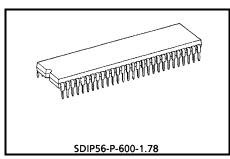
TOSHIBA BI-CMOS INTEGRATED CIRCUIT SILICON MONOLITHIC

TB1227CNG

VIDEO, CHROMA AND SYNCHRONIZING SIGNALS PROCESSING IC FOR PAL / NTSC / SECAM SYSTEM COLOR TV

TB1227CNG that is a signal processing IC for the PAL / NTSC / SECAM color TV system integrates video, chroma and synchronizing signal processing circuits together in a 56-pin shrink DIP plastic package.

TB1227CNG incorporates a high performance picture quality compensation circuit in the video section, an automatic PAL / NTSC / SECAM discrimination circuit in the chroma section, and an automatic 50 / 60Hz discrimination circuit in the synchronizing section. Besides a crystal oscillator that internally generates $4.43 \rm MHz, 3.58 \rm MHz$ and M / N-PAL clock signals for color demodulation, there is a horizontal PLL circuit built in the IC.



Weight: 5.55 g (typ.)

The PAL / SECAM demodulation circuit which is an adjustment-free circuit incorporates a 1H DL circuit inside for operating the base band signal processing system.

Also, TB1227CNG makes it possible to set or control various functions through the built-in I²C bus line.

FEATURES

Video section

- Built-in trap filter
- Black expansion circuit
- Variable DC regeneration rate
- · Y delay line
- · Sharpness control by aperture control
- y correction
- VSM output

Chroma section

- Built-in 1H Delay circuit
- PAL / SECAM base band demodulation system
- One crystal color demodulation circuit (4.43MHz, 3.58MHz, M / N-PAL)
- Automatic system discrimination, system forced mode
- 1H delay line also serves as comb filter in NTSC demodulation
- Built-in band-pass filter, SECAM bell filter
- Color limiter circuit
- Fsc output

Synchronizing deflecting section

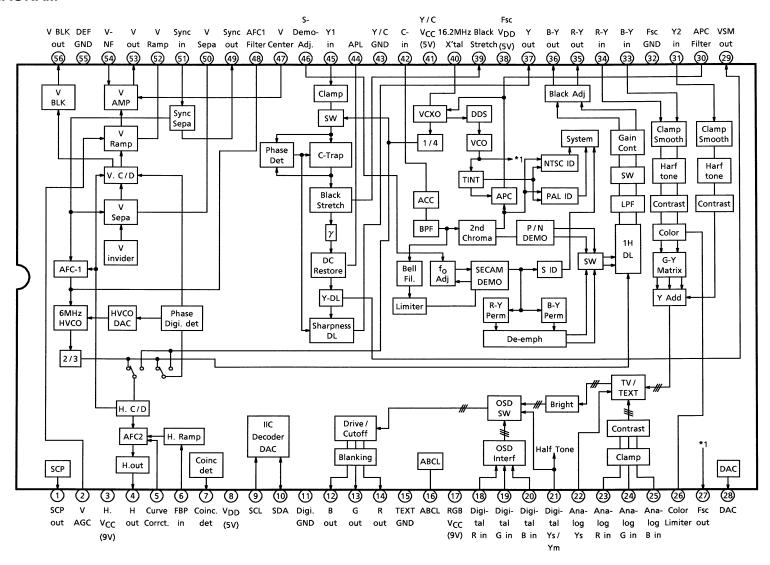
- Built-in horizontal VCO resonator
- · Adjustment-free horizontal / vertical oscillation by count-down circuit
- Double AFC circuit
- Vertical frequency automatic discrimination circuit
- Horizontal / vertical holding adjustment
- · Vertical ramp output
- · Vertical amplitude adjustment
- Vertical linearity / S-shaped curve adjustment

• SCP (Sand Castle Pulse) output

Text section

- Linear RGB input
- $\bullet \quad OSD \; RGB \; input$
- Cut / off-drive adjustment
- RGB primary signal output

BLOCK DIAGRAM



TERMINAL FUNCTIONS

PIN No.	PIN NAME	FUNCTION	INTERFACE CIRCUIT	INPUT / OUTPUTSIGNAL
1	SCP OUTPUT	Output terminal of Sand Castle Pulse. (SCP) To connect drive resistor for SCP.	OSSEA BPRK OSSEA O	Horizontal blanking 7.3 Clamping pulse 4.5 0.4 Vertical blanking
2	V-AGC	Controls pin 52 to maintain a uniform V-ramp output. Connect a current smoothing capacitor to this pin.	3 300Ω	_
3	H-V _{CC} (9V)	V _{CC} for the DEF block (deflecting system). Connect 9V (Typ.) to this pin.	-	_
4	Horizontal Output	Horizontal output terminal.	3 300Ω	5.0V 0.2V
5	Picture Distortion Correction	Corrects picture distortion in high voltage variation. Input AC component of high voltage variation. For inactivating the picture distortion correction function, connect 0.01µF capacitor between this pin and GND.	3 3 3 3 3 3 3 3 3 3 3 3 3 3	4.5V at Open
6	FBP Input	FBP input for generating horizontal AFC2 detection pulse and horizontal blanking pulse. The threshold of horizontal AFC2 detection is set H.V _{CC} -2V _f (V _f ≈0.75V). Confirming the power supply voltage, determine the high level of FBP.	3 3 AFC2 7 AFC2 7	H-VCC

PIN No.	PIN NAME	FUNCTION	INTERFACE CIRCUIT	INPUT / OUTPUT SIGNAL
7	Coincident Det.	To connect filter for detecting presence of H. synchronizing signal or V. synchronizing signal.	(3) (7) (2) (2) (1) (1) (1) (1) (1) (1) (1) (1) (1) (1	-
8	V _{DD} (5V)	V _{DD} terminal of the LOGIC block. Connect 5V (Typ.) to this pin.	_	_
9	SCL	SCL terminal of I ² C bus.	3 ΔSCI ΔSCI ΔSCI ΔSCI ΔSCI ΔSCI ΔSCI ΔSCI	I
10	SDA	SDA terminal of I ² C bus.	8 10 50Ω 10kΩ ACK ACK ACK ACK ACK ACK ACK ACK	I
11	Digital GND	Grounding terminal of LOGIC block.	_	
12 13 14	B Output G Output R Output	R, G, B output terminals.	12 13 14 100Ω 11 100Ω	<u></u>
15	TEXT GND	Grounding terminal of TEXT block.	_	_
16	ABCL	External unicolor brightness control terminal. Sensitivity and start point of ABL can be set through the bus.	(1) (1) (1) (1) (1) (1) (1) (1) (1) (1)	6.4V at Open
17	RGB-V _{CC} (9V)	V _{CC} terminal of TEXT block. Connect 9V (Typ.) to this pin.	_	—

PIN No.	PIN NAME	FUNCTION	INTERFACE CIRCUIT	INPUT / OUTPUT SIGNAL
18 19 20	Digital R Input Digital G Input Digital B Input	Input terminals of digital R, G, B signals. Input DC directly to these pins. OSD or TEXT signal can be input to these pins.	18 19 20 19 20 19 20	OSD 3.0V TEXT 2.0VGND
21	Digital YS / YM	Selector switch of halftone / internal RGB signal / digital RGB (pins 18, 19, 20).		OSD
22	Analog YS	Selector switch of internal RGB signal or analog RGB (pins 23, 24, 25).	22 1kΩ 7	Analog RGB
23 24 25	Analog R Input Analog G Input Analog B Input	Analog R, G, B input terminals. Input signal through the clamping capacitor. Standard input level: 0.5V _{p-p} (100 IRE).	23 24 25 25 28Ω 28Ω 28Ω 28Ω 28Ω 29Ω 29Ω 29Ω 29Ω 29Ω 29Ω 29Ω 29Ω 29Ω 29	100IRE = 0.5V _{p-p} 4.6V GND
26	Color Limiter	To connect filter for detecting color limit.	26 10kΩ 10kΩ Color Milimite	_
27	FSC Output	Output terminal of FSC.	2000 400 W 400 W 400 W	3.58MHz 3.58MHz Other 500mVp-p

PIN No.	PIN NAME	FUNCTION	INTERFACE CIRCUIT	INPUT / OUTPUT SIGNAL
28	1Bit DAC Output Terminal	Enable to change slave address to 8Ah by a connecting V _{CC} with this terminal.	30kΩ 30kΩ 30kΩ	4.5V (Date: (1)) 2.0V (Date: (0))
29	VSM Output Terminal	Power output the signal that is primary differentiated Y signal. Enable to change output amplifier and phase by the Bus.	150 MSA 33.5kD	_
30	APC Filter	To connect APC filter for chroma demodulation.	(4) 30000 3.2.7 3.2.8 3.2.9 3.0.0 3.0 3	DC 3.2V
31	Y ₂ Input	Input terminal of processed Y signal. Input Y signal through clamping capacitor. Standard input level: 0.7V _{p-p}	31 Y2: 2V R-Y, B-Y : 2.5V	0.7V _{p-p}
32	Fsc GND	Grounding terminal of VCXO block. Insert a decoupling capacitor between this pin and pin 38 (Fsc V _{DD}) at the shortest distance from both.	_	_
33 34	B-Y Input R-Y Input	Input terminal of B-Y or R-Y signal. Input signal through a clamping capacitor.	41 γ ₂ : 2V R-Y, B-Y : 2.5V Reg is a series of the se	DC 2.5V AC B-Y: 650mV _{p-p} R-Y: 510mV _{p-p} (with input of PAL-75% color bar signal)

PIN No.	PIN NAME	FUNCTION	INTERFACE CIRCUIT	INPUT / OUTPUT SIGNAL
35 36	R-Y Output B-Y Output	Output terminal of demodulated R-Y or B-Y signal. There is an LPF for removing carrier built in this pin.	41 W001 35 36 36 37081	DC 1.9V AC B-Y: 650mV _{p-p} R-Y: 510mV _{p-p} (with input of PAL-75% color bar signal)
37	Y Output	Output terminal of processed Y signal. Standard output level : 0.7V _{p-p}	SkΩ + 1000Ω	0.7V _{p-p}
38	Fsc V _{DD}	V _{DD} terminal of DDS block. Insert a decoupling capacitor between this pin and pin 32 (Fsc GND) at the shortest distance from both. If decouping capacitor is inserted at a distance from the pins, it may cause spurious deterioration.	_	_
39	Black Stretch	To connect filter for controlling black expansion gain of the black expansion circuit. Black expansion gain is determined by voltage of this pin.	39 1κΩ 1κΩ 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2	DC 1.6V
40	16.2MHz X'tal	To connect 16.2MHz crystal clock for generating sub-carrier. Lowest resonance frequency (f ₀) of the crystal oscillation can be varied by changing DC capacity. Adjust f ₀ of the oscillation frequency with the board pattern.	(40) 1,5kΩ (10) 1,5kΩ	DC 4.1V

PIN No.	PIN NAME	FUNCTION	INTERFACE CIRCUIT	INPUT / OUTPUT SIGNAL
41	Y / C V _{CC} (5V)	V _{CC} terminal of Y / C signal processing block.	_	_
42	Chroma Input	Chroma signal input terminal. Input negative 1.0V _{p-p} sync composite video signal to this pin through a coupling capacitor.	42 1kΩ (3) (3) (3) (4) (4) (4) (4) (4) (4) (4) (4) (4) (4	DC 2.4V AC : 300mV _{p-p} burst
43	Y / C GND	Grounding terminal of Y / C signal processing block.	_	_
44	APL	To connect filter for DC regeneration compensation. Y signal after black expansion can be monitored by opening this pin.	15kΩ	DC 2.2V
45	Y ₁ Input	Input terminal of Y signal. Input negative 1.0V _{p-p} sync composite video signal to this pin through a clamping capacitor.	41) 43) 200Ω 2kΩ 2kΩ 3 m m m m	1.0V _{p-p}
46	S-Demo-Adj.	To connect f_0 adjustment filter for SECAM demodulation.		DC 3.2V
47	V-Center	DC Output Terminal For V Centering. Enable to control output DC voltage by the bus.	100 AA 140 E	DC 2.7~6.3V

PIN No.	PIN NAME	FUNCTION	INTERFACE CIRCUIT	INPUT / OUTPUT SIGNAL
48	AFC1 Filter	To connect filter for horizontal AFC1 detection. Horizontal frequency is determined by voltage of this pin.	S.00/37.5kΩ (S.00/37.5kΩ) (S.0	DC 5.0V
49	Sync Output	Output terminal of synchronizing signal separated by sync separator circuit. Connect a pull-up resistor to this pin because it is an open-collector output type.	(49) \$\frac{50\Omega}{\text{m}}\$	
50	V-Sepa.	To connect filter for vertical synchronizing separation.	(S) 30000 \$5	DC 5.9V
51	Sync Input	Input terminal of synchronizing separator circuit. Input signal through a clamping capacitor to this pin. Negative 1.0V _{p-p} sync.	(3) S00Ω (1) (1) (1) (1) (1) (1) (1) (1) (1) (1)	1.0V _{p-p}
52	V-Ramp	To connect filter for generating V-ramp waveform.	(52) 14kΩ	1.9V _{p-p}

PIN No.	PIN NAME	FUNCTION	INTERFACE CIRCUIT	INPUT / OUTPUT SIGNAL
53	Vertical Output	Output terminal of vertical ramp signal.	3	7_7
54	V-NF	Input terminal of vertical NF signal.		2
55	DEF GND	Grounding terminal of DEF (deflection) block.	_	_
56	V BLK Output	Output terminal of V blanking.	300Ω 1kΩ (3) (3) (4) (3) (4) (3) (4) (3) (4) (4) (6) (7) (7) (7) (7) (7) (7) (7) (7) (7) (7	5V V blanking 0V

TOSHIBA

BUS CONTROL MAP

WRITE DATA
Slave address : 88H (Pin28-High : 8AH)

BLOCK	SUB ADDR	MSB 7	6	5	4	3	2	1	LSB 0	PRE	SET
	00	Uni-Color Color								1 0 0 0	0 0 0 0
	01	BRIGHT									0 0 0 0
	02				COL	.OR				1 0 0 0	0 0 0 0
VIDEO / TEXT	03	*				TINT				0 1 0 0	0 0 0 0
	04	P / N KIL	0			SHAR	PNESS			0 0 1 0	0 0 0 0
	05	DTrp-SW	R-Mon	B-Mon		Υ	SUB CONTRA	ST		1 0 0 1	0 0 0 0
	06				RGB-CO	NTRAST				1 0 0 0	0 0 0 0
_	07	*	*	*	*	*	*	*	*	1 0 0 0	0 0 0 0
	80	Υγ	WPL SW	0	BLUE BA	CK MODE		Y-DL SW		0 0 0 0	0 1 0 0
VIDEO / TEXT	09				G DRIV	E GAIN				1 0 0 0	0 0 0 0
	0A				B DRIVI	E GAIN				1 0 0 0	0 0 0 0
DEF	0B		HOR	ZONTAL POSIT	TON		AFC	MODE	H-CK SW	1 0 0 0	0 0 0 1
	0C				R CU1	OFF				0 0 0 0	0 0 0 0
TEXT (P / N)	0D	G CUT OFF							0 0 0 0	0 0 0 0	
TEXT (I 7 IV)	0E								0 0 0 0	0 0 0 0	
	0F	B. S. OFF	C-TRAP	OFST SW	C-TOF	P/NGP	CLL SW	WBLK SW	WMUT SW	0 0 0 0	0 0 0 0
SYSTEM	10	S-INHBT	358 Trap	F-B / W		X'tal MODE		COLOR	SYSTEM	0 0 0 0	0 0 0 0
	11		R-Y BLAC					B-Y BLACK OFFSET			1 0 0 0
P/N	12	CLL LI		PN CI		_	F Q	TOF		1 0 0 1	1 0 1 0
Vi / C	13	V-MODE	VSM PHASE	VSM			AP Q	C-TRA	AP FO	1 0 1 1	1 0 1 0
VIDEO (DEF)	14	BLAC	K STRETCH PO	TNIC		DC TRAN RATE		APA-CON	FO/SW	1 0 0 0	0 0 1 0
VIBEO (BEI)	15		ABL POINT			ABL GAIN		HALF TO	ONE SW	0 0 0 0	0 0 0 0
	16		H BLK PHASE			REQ		V OUT PHASE		0 0 0 0	0 0 0 0
	17				V-AMPLITUDE				*	1 0 0 0	0 0 0 0
GEOMETRY	18			V CENT	ERING			COINCID	ENT DET	1 0 0 0	0 0 1 0
	19			V	S-CORRECTIO	N			DRG SW	1 0 0 0	0 0 0 0
	1A			V LINEARITY			V-CD MD	DRV CNT	VAGC SP	0 0 0 0	0 0 0 1
	1B	MUTE I	MODE			WIDE V-BLK S	START PHASE			0 1 1 1	1 1 1 1
DEF-V	1C	BLK SW				V-BLK STOP P				0 0 0 0	0 0 0 0
DE1 V	1D	NOISE DE	T LEVEL			WIDE P-MUTE				1 0 1 1	1 1 1 1
	1E	N COMB				P-MUTE STOP				0 0 0 0	0 0 0 0
SECAM	1F	S-field	SCD ATT	DEMP FO	S GP	V-ID SW	S KIL	BEL	L FO	0 0 0 0	0 0 0 1

Note: *: Data is ignored.

2004-05-24 12

READ-IN DATA Slave address : 89H (Pin28-High : 8BH)

	MSB 7	6	5	4	3	2	1	LSB 0
00	PORES	COLOR SYSTEM		X'tal		V-FREQ	V-STD	N-DET
01	LOCK	RGBOUT	Y ₁ -IN	UV-IN	Y ₂ -IN	Н	٧	V-GUARD

BUS CONTROL FUNCTION WRITE FUNCTION

ITEM	DESCRIPTION	NUMBER OF BITS	VARIABLE RANGE	PRESET VALUE
UNI-COLOR	_	8bit	-18dB~0dB	80h MAX-5.0dB
BRIGHT	_	8bit	-1V~1V	80h 0V
COLOR	_	8bit	~0dB	80h -6dB
TINT	_	7bit	-45°~45°	40h 0°
P / N KIL	P / N KILLER sensitivity control	1bit	Normal / Low	00h NORMAL
SHARPNESS	_	6bit	-6dB~12dB	20h +3dB
DTrp-SW	SECAM double trap ON / OFF	1bit	ON / OFF	01h OFF
R-Mon	TEXT-11 dB pre-amplification UV output	1bit	Normal / Monitor	00h Normal
B-Mon	(Pin 35 : Bo, Pin 36 : Ro)	1bit	Normal / Monitor	00h Normal
Y SUB CONTRAST	_	5bit	-3dB~+3dB	10h 0dB
RGB-CONTRAST	EXT RGB UNI-COLOR control	8bit	-18dB~0dB	80h MAX - 5.0dB
Υγ	γ ON / OFF	1bit	OFF / 95 IRE	00h ON
WPL SW	White peak limit level	1bit	130 IRE / OFF	00h 130 IRE
BLUE BACK MODE	Luminance selector switch	2bit	IRE; OFF, 40, 50, 50	00h OFF
Y-DL SW	Y-DL TIME (28, 33, 38, 43, 48)	3bit	280~480ns after Y IN	04h 480ns
G DRIVE GAIN	_	8bit	-5dB~3dB	80h 0dB
B DRIVE GAIN	_	8bit	-5dB~3dB	80h 0dB
HORIZONTAL POSITION	Horizontal position adjustment	5bit	−3µs~+3µs	10h 0μs

ITEM	DESCRIPTION	NUMBER OF BITS	VARIABLE RANGE	PRESET VALUE
AFC MODE	AFC1 detection sensitivity selector	2bit	dB; AUTO, 0, -10, -10	00h AUTO
H-CK SW	HOUT generation clock selector	1bit	384fh-VCO, FSC-VCXO	01h FSC-VCXO
R CUT OFF	_	8bit	-0.5~0.5V	00h -0.5V
G CUT OFF	_	8bit	-0.5~0.5V	00h -0.5V
B CUT OFF	_	8bit	-0.5~0.5V	00h -0.5V
B. S. OFF	Black expansion ON / OFF	1bit	ON / OFF	00h ON
C-TRAP	Chroma Trap ON / OFF SW	1bit	ON / OFF	00h ON
FST SW	Black offset SECAM discrimination interlocking switch	1bit	SECAM only / All systems	00h S only
C-TOF	P/NTOF ON/OFF SW	1bit	ON / OFF	00h ON
P / N GP	PAL GATE position	1bit	Standard / 0.5µs delay	00h Standard
CL-L SW	COLOR LIMIT ON / OFF	1bit	ON / OFF	00h ON
WBLK SW	WIDE V-BLK ON / OFF	1bit	OFF / ON	00h OFF
WMUT SW	WIDE Picture-MUTE ON / OFF	1bit	OFF / ON	00h OFF
S-INHBT	To detect or not to detect SECAM	1bit	Yes / No	00h Yes
3.58 Trap	C Trap-f ₀ , force 3.58MHz switch	1bit	AUTO / Forced 3.58MHz	00h AUTO
F-B / W	Force B / W switch	1bit	AUTO / Forced B / W	00h AUTO
X'tal MODE	APC oscillation frequency selector switch	3bit	000 ; European system AUTO, 001 ; 3N 010 ; 4P 011 ; 4P (N inhibited) 100 ; S.American system AUTO 101 ; 3N 110 ; MP	00h European system AUTO
COLOR SYSTEM	Chroma system selection	2bit	AUTO, PAL, NTSC, SECAM	00h AUTO
R-Y BLACK OFFSET	R-Y color difference output black offset adjustment	4bit	-24~21mV STEP 3mV	08h 0mV
B-Y BLACK OFFSET	B-Y color difference output black offset adjustment	4bit	-24~21mV STEP 3mV	08h 0mV
CLL LEVEL	Color limit level adjustment	2bit	91, 100, 108, 116%	02h 108%

Note: 3N; 3.58-NTSC, 4P; 4.43-PAL, MP; M-PAL, NP; N-PAL

European system AUTO; 4.43-PAL, 4.43-NSTC, 3.58-NTSC, SRCAM

S. American system AUTO; 3.58-NTSC, M-PAL, N-PAL

ITEM	DESCRIPTION	NUMBER OF BITS	VARIABLE RANGE	PRESET VALUE
PN CD ATT	P / N color difference amplitude adjustment	2bit	+1~-2dB STEP 1dB	01h 0dB
TOF Q	TOF Q adjustment	2bit	1.0, 1.5, 2.0, 2.5	02h 2.0
TOF F ₀	TOF f ₀ adjustment	2bit	kHz ; 0, 500, 600, 700	02h 600kHz
VSM PHASE	VSM output phase	2bit	+20ns, +20ns, 0ns, 0ns	02h Ons
VSM GAIN	VSM output gain	2bit	0dB, 0dB, -6dB, OFF	03h OFF
C-TRAP Q	Chroma trap Q control	2bit	1.0, 1.5, 2.0, 2.5	02h 2.0
C-TRAP F ₀	Chroma trap f ₀ control	2bit	kHz; -100, -50, 0, +50	02h 0kHz
BLACK STRETCH POI	Black expansion start point setting	3bit	28~70% IRE×0.4	05h 56% IRE
DC TRAN RATE	Direct transmission compensation degree selection	3bit	100~130% APL	00h 100%
APA-CON PEAK F ₀	Sharpness peak frequency selection	2bit	kHz ; 2.5, 3.1, 4.2, OFF	02h 4.2kHz
ABL POINT	ABL detection voltage	3bit	ABL point ; 6.5V~5.9V	00h 6.5V
ABL GAIN	ABL sensitivity	3bit	Brightness ; 0~-2V	00h 0V
HALF TONE SW	Halftone gain selection	2bit	-3dB, -6dB, OFF, OFF	00h -3dB
H BLK PHASE	Horizontal blanking end position	3bit	0~3.5µs step 0.5µs	00h 0µs
V FREQ	Vertical frequency	2bit	AUTO, 60Hz, Forced 60, 50, 60	00h AUTO
V OUT PHASE	Vertical position adjustment	3bit	0~7H STEP 1H	00h 0H
V-AMPLITUDE	Vertical amplitude selection	7bit	-50~50%	40h 0%
1bit DAC	1bit DAC output	1bit	LOW, HIGH	00h LOW
V CENTERING	V Centering	6bit	1~4V	20h 2.5V
COINCIDENT MODE	Discriminator output signal selection	2bit	00; DSYNC 01; DSYNC×AFC 10; Field counting 11; VP is present.	02h Field counting
V S-CORRECTION	Vertical S-curve correction	7bit	Reverse S-curve, S-curve	40h —
V-MODE	Force Sync Mode Selection	1bit	TELETEXT / Normal	01h Normal
DRG SW	Drive reference axis selection	1bit	R/G	00h R
V LINEARITY	Vertical linearity correction	5bit	(one side)	00h —
ND SW	Noise Det SW	1bit	Normal, Low	00h Normal
V-CD MD	Vertical count-down mode selection	1bit	AUTO / Force synchronization	00h AUTO

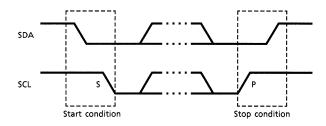
ITEM	DECODIDATION	NUMBER	VADIADI E DANGE	DDECET VALUE
ITEM	DESCRIPTION	OF BITS	VARIABLE RANGE	PRESET VALUE
DRV CNT	All drive gains forced centering switch	1bit	OFF / Force centering	00h OFF
VAGC SP	Vertical ramp time constant selection	1bit	Normal / High speed	01h High speed
MUTE MODE	OFF, RGB mute, Y mute, transverse	2bit	OFF, RGB, Y, Transverse	01h RGB
WIDE V-BLK START PH	Vertical pre-position selection	6bit	-64~-1H STEP 1H	3Fh −1H
BLK SW	Blanking ON / OFF	1bit	ON / OFF	00h ON
WIDE V-BLK STOP PH	Vertical post-position selection	7bit	0~128H STEP 1H	00h 0H
NOISE DET LEVEL	Noise detection level selection	2bit	0.20, 0.15, 0.10, 0.05	02h 0.1
WIDE P-MUTE START PH	Video mute pre-position selection	6bit	-64~-1H STEP 1H	3Fh −1H
N COMB	1H addition selection	1bit	OFF / ADD	00h OFF
WIDE P-MUTE STOP PH	Video mute post-position selection	7bit	0~128H STEP 1H	00h 0H
S-field	SECAM color and Q selection in weak electric field	1bit	Weak electric field control ON / OFF	00h ON
SCD ATT	SECAM color difference amplitude adjustment	1bit	0 / -1dB	00h 0dB
DEMO F ₀	SECAM deemphasis time constant selection	1bit	85kHz / 100kHz	00h 85kHz
S GP	SECAM gate position selection	1bit	Standard / 0.5µs delay	00h Standard
V-ID SW	SECAM V-ID ON / OFF switch	1bit	OFF / ON	00h OFF
S KIL	SECAM KILLER sensitivity selection	1bit	NORMAL / LOW	00h NORMAL
BELL F ₀	Bell f ₀ adjustment	2bit	-46~92kHz STEP 46kHz	01h 0kHz

READ-IN FUNCTION

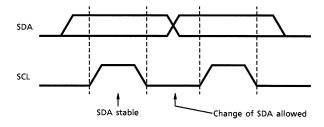
ITEM	DESCRIPTION	NUMBER OF BITS
PONRES	0 : POR cancel, 1 : POR ON	1bit
COLOR SYSTEM	00 : B / W, 01 : PAL 10 : NTSC, 11 : SECAM	2bit
X'tal	00 : 4.433619MHz 01 : 3.579545MHz 10 : 3.575611MHz (M-PAL) 11 : 3.582056MHz (N-PAL)	2bit
V-FREQ	0 : 50Hz, 1 : 60Hz	1bit
V-STD	0 : NON-STD, 1 : STD	1bit
N-DET	0 : Low, 1 : High	1bit
LOCK	0 : UN-LOCK, 1 : LOCK	1bit
RGBOUT, Y ₁ -IN UV-IN, Y ₂ -IN, H, V	Self-diagnosis 0 : NG, 1 : OK	1bit each
V-GUARD	Detection of breaking neck 0 : Abnormal, 1 : Normal	1bit

DATA TRANSFER FORMAT VIA I²C BUS

Start and stop condition

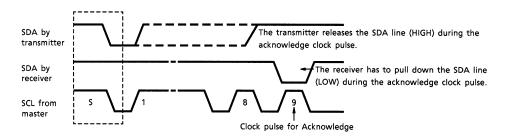


Bit transfer



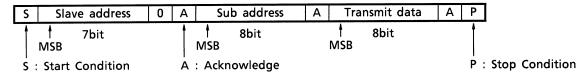
17

Acknowledge

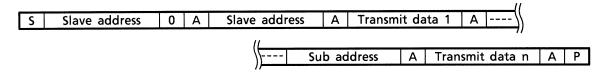




Data transmit format 1



Data transmit format 2



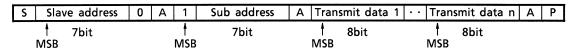
Data receive format



At the moment of the first acknowledge, the master transmitter becomes a master receiver and the slave receiver becomes a slave transmitter. This acknowledge is still generated by the slave.

The STOP condition is generated by the master.

Optional data transmit format : Automatic increment mode



In this transmission method, data is set on automatically incremented sub-address from the specified sub-address.

Purchase of TOSHIBA I^2C components conveys a license under the Philips I^2C Patent Rights to use these components in an I^2C system, provided that the system conforms to the I^2C Standard Specification as defined by Philips.

MAXIMUM RATINGS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	RATING	UNIT
Supply Voltage	V _{CCMAX}	12	V
Permissible Loss	P _{DMAX}	2190 (Note)	mW
Power Consumption Declining Degree	1 / Q _{ja}	17.52	mW / °C
Input Terminal Voltage	V _{in}	GND - 0.3~V _{CC} + 0.3	V
Input Signal Voltage	e _{in}	7	V _{p-p}
Operating Temperature	T _{opr}	-20~65	°C
Conserving Temperature	T _{stg}	-55~150	°C

Note: In the condition that IC is actually mounted. See the diagram below.

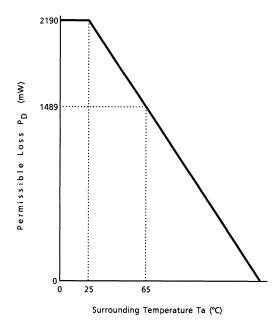


Fig. Power consumption declining curve relative to temperature change

OPERATING CONDITIONS

CHARACTERISTIC	DESCRIPTION	MIN	TYP.	MAX	UNIT
Supply Voltage	Pin 3, pin 17	8.50	9.0	9.25	V
Supply Voltage	Pin 8, pin 38, pin 41	4.75	5.0	5.25	
Video Input Level		0.9	1.0	1.1	
Chroma Input Level	100% white, negative sync	0.9	1.0	1.1	V _{p-p}
Sync Input Level		0.9	1.0	2.2	
FBP Width	_	11	12	13	μs
Incoming FBP Current (Note)	_	_	_	1.5	A
H. Output Current	_	-	1.0	2.0	mA
RGB Output Current	_	_	1.0	2.0	
Analog RGB Input Level	_	_	0.7	0.8	
OCD DCD langet Layer	In TEXT input		1.0	1.3	V
OSD RGB Input Level	In OSD input	_	4.2	5.0	
Incoming Current to Pin 49	Sync-out	_	0.5	1.0	mA

Note: The threshold of horizontal AFC2 detection is set $H.V_{CC}-2V_f$ ($V_f\approx 0.75V$). Confirming the power supply voltage, determine the high level of FBP.

ELECTRICAL CHARACTERISTIC (Unless otherwise specified, H, RGB V_{CC} = 9V, V_{DD} , Fsc V_{DD} , Y / C V_{CC} = 5V, Ta = 25°C) CURRENT CONSUMPTION

PIN No.	CHARACTERISTIC	SYMBOL	TEST CIR- CUIT	MIN	TYP.	MAX	UNIT
3	H.V _{CC} (9V)	I _{CC1}	_	16.0	19.0	23.5	
8	V _{DD} (5V)	I _{CC2}	_	8.8	11.0	14.0	
17	RGB V _{CC} (9V)	I _{CC3}		25.0	31.5	39.0	mA
38	Fsc V _{CC} (5V)	I _{CC4}	_	6.8	8.5	11.0	
41	Y / C V _{CC} (9V)	I _{CC5}	_	80	100	130	

TERMINAL VOLTAGE

PIN No.	PIN NAME	SYMBOL	TEST CIR- CUIT	MIN	TYP.	MAX	UNIT
16	ABCL	V ₁₆	_	5.9	6.4	6.9	V
18	OSD R Input	V ₁₈	_	_	0	0.3	V
19	OSD G Input	V ₁₉	_	_	0	0.3	V
20	OSD B Input	V ₂₀	_	_	0	0.3	V
21	Digital Ys	V ₂₁	_	1	0	0.3	V
22	Analog Ys	V ₂₂	_		0	0.3	٧
23	Analog R Input	V ₂₃	_	4.2	4.6	5.0	V
24	Analog G Input	V ₂₄	_	4.2	4.6	5.0	٧
25	Analog B Input	V ₂₅	_	4.2	4.6	5.0	V
28	DAC	V ₂₈	_	1.7	2.0	2.3	V
31	Y ₂ Input	V ₃₁	_	1.7	2.0	2.3	٧
33	B-Y Input	V ₃₃	_	2.2	2.5	2.8	V
34	R-Y Input	V ₃₄	_	2.2	2.5	2.8	٧
35	R-Y Output	V ₃₅	_	1.5	1.9	2.3	٧
36	B-Y Output	V ₃₆	_	1.5	1.9	2.3	٧
37	Y ₁ Output	V ₃₇	_	1.9	2.3	2.7	V
40	16.2MHz X'tal Oscillation	V ₄₀	_	3.6	4.1	4.6	V
42	Chroma Input	V ₄₂	_	2.0	2.4	2.8	V
50	V-Sepa.	V ₅₀	_	5.4	5.9	6.4	V

AC CHARACTERISTIC Video section

CHARACTERISTIC	SYMBOL	TEST CIR- CUIT	TEST CONDITION	MIN	TYP.	MAX	UNIT	
Y Input Pedestal Clamping Voltage	VYclp	_	(Note Y ₁)	2.0	2.2	2.4	V	
	ftr3	_	41.4.34.3	3.429	3.58	3.679	MHz	
Chroma Trap Frequency	ftr4	_	(Note Y ₂)	4.203	4.43	4.633		
Chroma Trap Attenuation	Gtr3a	_	(A) (A)	00	-00			
(3.58MHz)	Gtr3f	_	(Note Y ₃)	20	26	52		
(4.43MHz)	Gtr4	_	(Note Y ₄)	20	26	52	dB	
(SECAM)	Gtrs	_	(Note Y ₅)	18	26	52		
Yγ Correction Point	үр	_	(Note Y ₆)	90	95	99	_	
Yγ Correction Curve	үс	_	(Note Y ₇)	-2.6	-2.0	-1.3	dB	
APL Terminal Output Impedance	Zo44	_	(Note Y ₈)	15	20	25	kΩ	
DC Transmission Compensation	Adrmax	_	(A) (A)	0.11	0.13	0.15		
Amplifier Gain	Adrent	_	(Note Y ₉)	0.44	0.06	0.08	times	
Maximum Gain of Black Expansion Amplifier	Ake	_	(Note Y ₁₀)	1.20	1.5	1.65		
	VBS9MX	_		65	77.5	80	· IRE	
	VBS9CT	_		55	62.5	70		
Plack Evannian Start Point	VBS9MN	_	(Note V)	48	55.5	63		
Black Expansion Start Point	VBS2MX	_	(Note Y ₁₁)	35	42.5	50		
	VBS2CT	_		25	31.5	38		
	VBS2MN	_		19	25.5	32		
Black Peak Detection Period (Horizontal)	TbpH	_	(Note Y ₁₂)	15	16	17	μs	
(Vertical)	TbpV	_		33	34	35	Н	
	fp25	_		1.5	2.5	3.4		
Picture Quality Control Peaking Frequency	fp31	_	(Note Y ₁₃)	1.9	3.1	4.3	MHz	
	fp42	_		3.0	4.2	5.4		
	GS25MX	_		12.0	14.5	17.0		
Picture Quality Control Maximum Characteristic	GS31MX	_	(Note Y ₁₄)	12.0	14.5	17.0		
	GS42MX	_		10.6	13.5	16.4		
	GS25MN	_		-22.0	-19.5	-17.0		
Picture Quality Control Minimum Characteristic	GS31MN	_	(Note Y ₁₅)	-22.0	-19.5	-17.0		
	GS42MN	_		-19.5	-16.5	-13.5	dB	
	GS25CT	_		6.0	8.5	11.0		
Picture Quality Control Center Characteristic	GS31CT	_	(Note Y ₁₆)	6.0	8.5	11.0		
	GS42CT			4.6	7.5	10.4		
Y Signal Gain	Gy	_	(Note Y ₁₇)	-1.0	0	1.6		
Y Signal Frequency Characteristic	Gfy		(Note Y ₁₈)	-6.5	0	1.0		
Y Signal Maximum Input Range	Vyd	_	(Note Y ₁₉)	0.9	1.2	1.5	V	

Chroma section

CHARACTERISTIC	SYMBOL	TEST CIR- CUIT	TEST CONDITION	MIN	TYP.	MAX	UNIT
	3N _{eAT}	_		30	35	90	mV _{p-p}
	3N _{F1T}	_		68	85	105	
ACC Characteristic	3N _{AT}	_		0.9	1.0	1.1	
$f_0 = 3.58$	3N _{eAE}	_		18	35	_	i
	3N _{F1E}	_		71	85	102	times
	3N _{AE}	_		0.9	1.0	1.1	
	4N _{eAT}	_	(Note C ₁)	18	35	_	\/
	4N _{F1T}	_		71	85	102	mV _{p-p}
	4N _{AT}	_		0.9	1.0	1.1	
$f_0 = 4.43$	4N _{eAE}	_		18	35	_	4:
	4N _{F1E}	_		71	85	102	times
	4N _{AE}	_		0.9	1.0	1.1	
	3Nfo ₀	_		3.43	3.579	3.73	
Band Pass Filter Characteristic $f_0 = 3.58$	3Nfo ₅₀₀	_		3.93	4.079	4.23	
	3Nfo ₆₀₀	_	(Nata C.)	4.03	4.179	4.33	
	3Nfo ₇₀₀	_		4.13	4.279	4.43	
	4Nfo ₀	_	(Note C ₂)	4.28	4.433	4.58	
5 - 4.40	4Nfo ₅₀₀	_		4.78	4.933	4.58	
f _o = 4.43	4Nfo ₆₀₀	_		4.88	5.033	5.18	
	4Nfo ₇₀₀	_		4.98	5.133	5.28	
	fo ₀	_					
Band Pass Filter, −3dB Band	fo ₅₀₀	_		4.04	4.70	4.04	
Characteristic $f_0 = 3.58$	fo ₆₀₀	_		1.64	1.79	1.94	
	fo ₇₀₀	_	(N-4- O)				N41.1-
	fo ₀	_	(Note C ₃)				MHz
5 - 4.40	fo ₅₀₀	_		0.07	0.00	0.07	
f _o = 4.43	fo ₆₀₀	_		2.07	2.22	2.37	
	fo ₇₀₀	_					
	Q ₁	_		_	3.58	_	
Band Pass Filter, Q Characteristic	Q _{1.5}	_		_	2.39	_	
Check $f_0 = 3.58$	Q _{2.0}	_		1.64	1.79	1.94	
	Q _{2.5}	_		_	1.43	_	
	Q ₁	_	(Note C ₄)	_	4.43	_	
	Q _{1.5}	l _		_	2.95	_	
f ₀ = 4.43	Q _{2.0}	l _		2.07	2.22	2.37	
	Q _{2.5}	_		_	1.77	_	

CHARACTERISTIC	SYMBOL	TEST CIR- CUIT	TEST CONDITION	MIN	TYP.	MAX	UNIT
	fo ₀	_		1.45	1.60	1.75	
1 / 2 f _c Trap Characteristic	fo ₅₀₀	_		1.70	1.85	2.00	
$f_0 = 3.58$	fo ₆₀₀	_		1.75	1.90	2.06	
	fo ₇₀₀	_	(Note C ₅)	1.80	1.95	2.10	MHz
	fo ₀	_	(Note C5)	1.85	2.00	2.15	IVIITIZ
f _o = 4.43	fo ₅₀₀	_		2.00	2.15	2.30	
10 - 4.43	fo ₆₀₀	_		2.05	2.20	2.35	
	fo ₇₀₀	_		2.10	2.25	2.40	
	3ΝΔθ1	_		35.0	45.0	55.0	
Tint Control Range	3ΝΔθ2	_	(Note C.)	-55.0	-45.0	-35.0	
$(f_0 = 600kHz)$	4ΝΔθ1	_	(Note C ₆)	35.0	45.0	55.0	٥
	4ΝΔθ2	_		33.0	45.0	33.0	
Tint Control Variable Range	3ΝΔθΤ	_	(Note C-)	70.0	00.0	110.0	
$(f_0 = 600kHz)$	4ΝΔθΤ	_	(Note C ₇)	70.0	90.0	110.0	
	3T0Tin	_		39	40	47	bit
	3EθTin	_		39	40	71	bit
Tint Control Characteristic	3N∆Tin	_	(Note C ₈)	73	80	87	Step
Till Control Characteristic	4TθTin	_		39	40	47	bit
	4EθTin	_		39	40	47	DIL
	4N∆Tin	_		73	80	87	Step
	4.433PH	_		350	500	1500	
APC Lead-In Range	4.433PL	_		-350	-500	-1500	
(Lead-In Range)	3.579PH	_		350	500	1700	
	3.579PL	_	(Note C ₉)	-350	-500	-1700	l l
	4.433HH	_	(Note Cg)	400	500	1100	Hz
(Variable Range)	4.433HL	_		-400	-500	-1100	
(variable Rafige)	3.579HH	_		400	500	1100	
	3.579HL	_		-400	-500	-1100	
	3.58β3	_		1.50	2.2	2.90	
ADC Control Consitiuity	4.43β3	_	(Not- 0)	1.70	2.4	3.10	
APC Control Sensitivity	M-PALβM	_	(Note C ₁₀)	1.50	2.2	2.00	_
	N-PALβN	_		1.50 2	2.2	2.90	

CHARACTERISTIC	SYMBOL	TEST CIR- CUIT	TEST CONDITION	MIN	TYP.	MAX	UNIT
	3N-VTK1	_		1.8	2.5	3.2	
	3N-VTC1	_		2.2	3.2	4.0	
	3N-VTK2	_		2.5	3.6	4.5	
	3N-VTC2	_		3.2	4.5	5.6	
	4N-VTK1	_		1.8	2.5	3.2	
	4N-VTC1	_		2.2	3.2	4.0	
	4N-VTK2	_		2.5	3.6	4.5	
	4N-VTC2	_		3.2	4.5	5.6	
	4P-VTK1	_		1.8	2.5	3.2	
	4P-VTC1	_	41.1.0	2.2	3.2	4.0	
Killer Operation Input Level	4P-VTK2	_	(Note C ₁₁)	2.5	3.6	4.5	
	4P-VTC2	_		3.2	4.5	5.6	
	MP-VTK1	_		1.8	2.5	3.2	
	MP-VTC1	_		2.2	3.2	4.0	.,
	MP-VTK2	_		2.5	3.6	4.5	- mV _{p-p}
	MP-VTC2	_		3.2	4.5	5.6	
	NP-VTK1	_		1.8	2.5	3.2	
	NP-VTC1	_		2.2	3.2	4.0	
	NP-VTK2	_		2.5	3.6	4.5	
	NP-VTC2	_		3.2	4.5	5.6	
	3NeB-Y	_		320	380	460	
	3NeR-Y	_		240	290	350	
Color Difference Output	4NeB-Y	_		320	380	460	
(Rainbow Color Bar)	4NeR-Y	_	(1)-4- (2)	240	290	350	
	4PeB-Y	_	(Note C ₁₂)	360	430	520	
	4PeR-Y	_		200	240	290	
/==× 0 D	4Peb-y	_		540	650	780	
(75% Color Bar)	4Per-y	_		430	510	610	
	3NG _{R / B}	_		0.69	0.77	0.86	
Demodulation Relative Amplitude	4NG _{R / B}	_	(Note C ₁₃)	0.70	0.77	0.85	times
	4PG _{R / B}	_		0.49	0.56	0.64	
	3NθR-B	_		85	93	100	
Demodulation Relative Phase	4NθR-B	_	(Note C ₁₄)	87	93	99	٥
	4PθR-B	_		85	90	95	
	3N-SCB	_					
Demodulation Output Residual	3N-SCR	_				4-	
Carrier	4N-SCB	_	(Note C ₁₅)	0 5	15	mV _{p-p}	
	4N-SCR	_					

CHARACTERISTI	C	SYMBOL	TEST CIR- CUIT	TEST CONDITION	MIN	TYP.	MAX	UNIT
		3N-HCB	_					\
Demodulation Output Resid	dual	3N-HCR	_	(Note C ₁₆)	0	10	30	
Higher Harmonic		4N-HCB	_	(11010 0 16)	U	10		mV _{p-p}
		4N-HCR	_					
		B-Y - 1dB	_		-1.20	-0.9	-0.60	
Color Difference Output ATT Check		B-Y - 2dB	_	(Note C ₁₇)	-2.30	-1.7	-1.55	dB
		B-Y+1dB	_		0.60	0.8	1.20	
16.2MHz Oscillation Frequency		ΔfoF	_	(Note C ₁₈)	-2.0	0	2.0	kHz
16.2MHz Oscillation Start V	/oltage	VFon1	_	(Note C ₁₉)	3.0	3.2	3.4	V
f _{SC} Free-Run Frequency	(3.58M)	3fr	_		-100	50	200	
	(4.43M)	4fr	_	(Note C ₂₀)	-125	25	175	Hz
	(M-PAL)	Mfr	_	, 20/	-125	25	175	
	(N-PAL)	Nfr	_		-140	10	160	
f Output Amplitude		4.43e27	_	(Note C-1)	420	500	580	m\/
f _{sc} Output Amplitude		3.58e27	_	(Note C ₂₁)	420	500	300	mV _{p-p}
f Output DC Voltage		3.58eV27	_		2.6	2.9	3.2	V
f _{sc} Output DC Voltage		0th V27	_	_	1.6	1.9	2.2	V

DEF section

CHARACTERISTIC	SYMBOL	TEST CONDITION NCUIT		MIN	TYP.	MAX	UNIT
H. Reference Frequency	FHVCO	_	(Note DH1)	5.95	6.0	6.10	MHz
H. Reference Oscillation Start Voltage	VSHVCO	_	(Note DH2)	2.3	2.6	2.9	V
H. Output Frequency 1	fH1	_	(Note DH3)	15.5	15.625	15.72	kHz
H. Output Frequency 2	fH2	_	(Note DH4)	15.62	15.734	15.84	NI IZ
H. Output Duty 1	Нф1	_	(Note DH5)	39	41	43	%
H. Output Duty 2	Нф2	_	(Note DH6)	35	37	39	70
H. Output Duty Switching Voltage 1	V ₅₋₁	_	(Note DH7)	1.2	1.5	1.8	
H. Output Voltage	VHH	_	(Note DH8)	4.5	5.0	5.5	V
n. Output voltage	VHL	_	(Note Dilo)	_	_	0.5	v
H. Output Oscillation Start Voltage	VHS	_	(Note DH9)	_	5.0	_	
H. FBP Phase	φFBP	_	(Note DH10)	6.2	6.9	7.6	
H. Picture Position, Maximum	HSFTmax	_	(Note DH11)	17.7	18.4	19.1	
H. Picture Position, Minimum	HSFTmin	_	(Note DH12)	12.4	13.1	13.8	μs
H. Picture Position Control Range	ΔHSFT	_	(Note DH13)	4.5	5.3	6.1	

CHARACTERISTIC	SYMBOL	TEST CIR- CUIT	TEST CONDITION	MIN	TYP.	MAX	UNIT
H. Distortion Correction Control Range	ΔHCC	_	— (Note DH14)		1.0	1.5	μs / V
H. BLK Phase	φBLK	_	(Note DH15)	6.2	6.9	7.6	
H. BLK Width, Minimum	BLKmin	_	(Note DH16)	9.8	10.5	11.3	
H. BLK Width, Maximum	BLKmax	_	(Note DH17)	13.2	14.0	14.7	
P / N-GP Start Phase 1	SPGP1	_	(Note DH18)	3.45	3.68	3.90	
P / N-GP Start Phase 2	SPGP2	_	(Note DH19)	3.95	4.18	4.40	
P / N-GP Gate Width 1	PGPW1	_	(Note DH20)	1.65	1.75	1.85	μs
P / N-GP Gate Width 2	PGPW2	_	(Note DH21)	1.70	1.75	1.85	
SECAM-GP Start Phase 1	SSGP1	_	(Note DH22)	5.2	5.4	5.6	
SECAM-GP Start Phase 2	SSGP2	_	(Note DH23)	5.7	6.0	6.2	
SECAM-GP Gate Width 1	SGPW1	_	(Note DH24)	1.9	2.0	2.1	
SECAM-GP Gate Width 2	SGPW2	_	(Note DH25)	1.9	2.0	2.1	
Noise Detection Level 1	NL1	_	(Note DH26)	0.12	0.20	0.28	
Noise Detection Level 2	NL2	_	(Note DH27)	0.10	0.15	0.20	.,
Noise Detection Level 3	NL3	_	(Note DH28)	0.05	0.10	0.15	V _{p-p}
Noise Detection Level 4	NL4	_	(Note DH29)	0.025	0.05	0.08	
V. Ramp Amplitude	Vramp	_	(Note DV1)	1.62	2.0	2.08	
V. NF Maximum Amplitude	VNFmax	_	(Note DV2)	3.2	3.5	3.8	V _{p-p}
V. NF Minimum Amplitude	VNFmin	_	(Note DV3)	0.8	1.0	1.2	
V. Amplification Degree	GVA	_	(Note DV4)	20	26	32	dB
V. Amplifier Max. Output	Vvmax	_	(Note DV5)	5.0	_	_	V
V. Amplifier Min. Output	Vvmin	_	(Note DV6)	0	_	1.5	v
V. S-Curve Correction, Max. Correction Quantity	V _S	_	(Note DV7)	9	11	13	
V. Reverse S-Curve Correction, Max. Correction Quantity	V _{SR}	_	(Note DV8)	9	11	13	%
V. Linearity Max. Correction Quantity	V_{L}	_	(Note DV9)	9	20	31	

CHARACTERISTIC	SYMBOL	TEST CIR- CUIT	TEST CONDITION	MIN	TYP.	MAX	UNIT
AFC-MASK Start Phase	φAFCf	_	(Note DV10)	2.6	3.2	3.8	
AFC-MASK Stop Phase	φAFCe	_	(Note DV11)	4.4	5.0	5.6	
VNFB phase	φVNFB	_	(Note DV12)	0.45	0.75	1.05	
V. Output Maximum Phase	Vømax	_	(Note DV13)	7.3	8.0	8.7	
V. Output Minimum Phase	Vømin	_	(Note DV14)	0.5	1.0	1.5	Н
V. Output Phase Variable Range	ΔVφ	_	(Note DV15)	6.3	7.0	7.7	
50 System VBLK Start Phase	V50BLKf	_	(Note DV16)	0.4	0.55	0.7	
50 System VBLK Stop Phase	V50BLKe	_	(Note DV17)	20	23	26	
60 System VBLK Start Phase	V60BLKf	_	(Note DV18)	0.4	0.55	0.7	
60 System VBLK Stop Phase	V60BLKe	_	(Note DV19)	15	18	21	
Pin 56 VBLK Max Voltage	V56H	_		4.7	5.0	5.3	V
Pin 56 VBLK Min Voltage	V56L	_		0	_	0.3	V
V. Lead-In Range 1	VAcaL	_	(Note DV20)	_	232.5	_	
v. Leau-III Range 1	VAcaH	_	(Note DV20)	_	344.5	_	Hz
V. Lead-In Range 2	V60caL	_	(Note DV21)	_	232.5	_	ΠZ
v. Leau-III Range 2	V60caH	_	(Note DV21)	_	294.5	_	
W-VBLK Start Phase	SWVB	_	(Note DV22)	9		88	
W-PMUTE Start Phase	SWP	_	(Note DV23)	9	_	00	Н
W-VBLK Stop Phase	STWVB	_	(Note DV24)	10		120	П
W-PMUTE Stop Phase	STWP	_	(Note DV25)	10	_	120	
V Centering Center Voltage	V51	_	(Note DV26)	_	4.55	_	
V Centering Max Voltage	V51Max	_	(Note DV27)	_	6.30	_	
V Centering Min Voltage	V51Min	_	(Note DV28)	_	2.75	_	V
Pin 28 DAC Output Voltage (High)	V28H	_		4.0	4.5	5.0	
Pin 28 DAC Output Voltage (Low)	V28L	_		_	0	0.1	

1H DL section

CHARACTERISTIC	SYMBOL	TEST CIR- CUIT	TEST CONDITION	MIN	TYP.	MAX	UNIT	
1HDL Dynamic Range, Direct	VNBD	_	(Note H ₁)	0.8	1.2	_		
,	VNRD		` ''					
1HDL Dynamic Range, Delay	VPBD		(Note H ₂)	0.8	1.2	_	V	
	VPRD	_						
1HDL Dynamic Range, Direct+Delay	VSBD		(Note H ₃)	0.9	1.2	_		
	VSRD	_	(1.0.0 1.3)	0.0				
Frequency Characteristic, Direct	GHB1	_	(Note H ₄)	-3.0	-2.0	0.5		
Troquency enaractoricus, Birest	GHR1	_	(11010 114)	0.0	2.0	0.0		
Frequency Characteristic, Delay	GHB2	_	(Note H ₅)	-8.2	-6.5	-4.3		
requeriey orial acteristic, belay	GHR2	_	(14010 115)	0.2	0.5	4.5		
AC Gain, Direct	GBY1	_	(Note H ₆)	-2.0	-0.5	2.0	dB	
AC Gain, Direct	GRY1	_	(11016-116)	2.0	0.5	2.0	uБ	
AC Gain, Delay	GBY2	_	(Note H ₇)	-2.4	-0.5	1.1		
AC Gairi, Delay	GRY2	_	(Note 117)	-2.4	-0.5	1.1		
Direct-Delay AC Gain Difference	GBYD	_	(Note H ₈)	-1.0	0.0	1.0		
Direct-Delay AC Gain Difference	GRYD	_	(11016-118)	1.0	0.0	1.0		
Color Difference Output DC Stepping	VBD	_	(Note H ₉)	- 5	0.0	5	mV	
Color Billerence Cutput De Stepping	VRD	_	(Note rig)	3	0.0		1110	
1H Delay Quantity	BDt	_	(Note H ₁₀)	63.7	64.0	64.4	μs	
Tr belay Quartity	RDt	_	(140te 1110)	05.7	04.0	04.4	μδ	
Color Difference Output	Bomin	_		22	36	55		
DC-Offset Control	Bomax	_	(Niete III)	-55	-36	-22		
Bus-Min Data	Romin	_	(Note H ₁₁)	22	36	55	ma\ /	
Bus-Max Data	Romax	_		-55	-36	-22	mV	
Color Difference Output DC-Offset	Bo1	_	(Note II)	1	4	۰		
Control / Min. Control Quantity	Ro1	_	(Note H ₁₂)	1	4	8		
NITCO Mada Cain / NITCO COM C.	GNB	_	/NI_1_ 11 \	-0.90	0	1.20	4D	
NTSC Mode Gain / NTSC-COM Gain	GNR	_	(Note H ₁₃)	0.92	0	1.58	dB	

CHARACTERISTIC	SYMBOL	TEST CIR- CUIT	TEST CONDITION	MIN	TYP.	MAX	UNIT
	Vcp31	_		1.7	2.0	2.3	
Y Color Difference Clamping Voltage	Vcp33	_	(Note T ₁)	2.2	2.5	2.8	
	Vcp34	_		2.2	2.5	2.0	
	Vc12mx	_		2.50	3.00	3.50	
	Vc12mn	_		0.21	0.31	0.47	
	D12c80	_		0.83	1.24	1.86	V
	Vc13mx	_		2.50	3.00	3.50	\ \ \
Contrast Control Characteristic	Vc13mn	_	(Note T ₂)	0.21	0.31	0.47	
	D13c80	_		0.83	1.24	1.86	
	Vc14mx	_		2.50	3.00	3.50	
	Vc14mn	_		0.21	0.31	0.47	
	D14c80	_		0.83	1.24	1.86	
	Gr	_					
AC Gain	Gg	_	(Note T ₃)	2.8	3 4.0	5.2	times
	Gb	_					
Frequency Characteristic	Gf	_	(Note T ₄)	_	-1.0	-3.0	dB
Y Sub-Contrast Control Characteristic	ΔVscnt	_	(Note T ₅)	3.0	6.0	9.0	
Y ₂ Input Range	Vy2d	_	(Note T ₆)	0.7	_	_	
	Vn12mx	_		1.6	2.3	4.3	
	Vn12mn	_		0.17	0.35	0.42	
	D12n80	_		0.67	1.16	1.68]
	Vn13mx	_		1.6	2.3	4.3	
Unicelar Control Characteristic	Vn13mn	_	(Note T.)	0.17	0.35	0.42	
Unicolor Control Characteristic	D13n80	_	(Note T ₇)	0.67	1.16	1.68	
	Vn14mx	_		1.6	2.3	4.3	
	Vn14mn	_		0.17	0.26	0.42	
	D14n80	_		0.67	1.16	1.68	
	ΔV13un	_		16	20	24	dB
Deletine Ameritande (NTCC)	Mnr-b	_	(Note T.)	0.70	0.77	0.85	timoso
Relative Amplitude (NTSC)	Mng-b	_	(Note T ₈)	0.30	0.34	0.38	times
Polotivo Phono (NTCC)	θnr-b	_	/Alata T \	87	93	99	۰
Relative Phase (NTSC)	θng-b	_	(Note T ₉)	235	241.5	248	
Polotivo Amplitudo (PAL)	Mpr-b	_	/Note T	0.50	0.56	0.63	times
Relative Amplitude (PAL)	Mpg-b	_	(Note T ₁₀)	0.30	0.34	0.38	times
Relative Phase (PAL)	θpr-b	_	/Note T	86	90	94	0
INGIALIVE FIIASE (FAL)	θpg-b	_	(Note T ₁₁)	232	237	242	

CHARACTERISTIC	SYMBOL	TEST CIR- CUIT	TEST CONDITION	MIN	TYP.	MAX	UNIT
	Vcmx	_		1.50	1.80	2.10	V _{p-p}
Color Control Characteristic	e _{col}	_	(Note T ₁₂)	80	128	160	aton
	Δ_{col}	_		142	192	242	step
	e _{cr}	_					
Color Control Characteristic, Residual Color	e _{cg}	_	(Note T ₁₃)	0	12.5	25	\ /
	e _{cb}	_					mV _{p-p}
Chroma Input Range	Vcr	_	(Note T ₁₄)	700	_	_	
Drightness Control Characteristic	Vbrmx	_	(Note T)	3.05	3.45	3.85	
Brightness Control Characteristic	Vbrmn	_	(Note T ₁₅)	1.05	1.35	1.65	V
Brightness Center Voltage	Vbcnt	_	(Note T ₁₆)	2.05	2.30	2.55	
Brightness Data Sensitivity	ΔVbrt	_	(Note T ₁₇)	6.3	7.8	9.4	\/
RGB Output Voltage Axes Difference	ΔVbct	_	(Note T ₁₈)	-150	0	150	mV
White Peak Limit Level	Vwpl	_	(Note T ₁₉)	2.63	3.25	3.75	
0 + 50 + 10 + 11	Vcomx	_	(N. (. T.)	2.55	2.75	2.95	.,
Cutoff Control Characteristic	Vcomn	_	(Note T ₂₀)	1.55	1.75	1.95	V
Cutoff Center Level	Vcoct	_	(Note T ₂₁)	2.05	2.3	2.55	
Cutoff Variable Range	ΔDcut	_	(Note T ₂₂)	2.3	3.9	5.5	mV
	DR+	_	41.4 = 3	2.7	3.85	5.0	
Drive Variable Range	DR-	_	(Note T ₂₃)	-6.5	-5.6	-4.7	dB
DC Regeneration	TDC	_	(Note T ₂₄)	0	50	100	mV
RGB Output S / N Ratio	SNo	_	(Note T ₂₅)	_	-50	-45	dB
Displains Dules Outset Lavel	Vv	_	(N-4- T.)	0.7	4.0	4.0	.,
Blanking Pulse Output Level	Vh	_	(Note T ₂₆)	0.7	1.0	1.3	V
Planking Pulsa Dalay Tima	t _{don}	_	(Note T)	0.05	0.25	0.45	
Blanking Pulse Delay Time	t _{doff}	_	(Note T ₂₇)	0.05	0.35	0.85	μs
RGB Min. Output Level	Vmn	_	(Note T ₂₈)	0.8	1.0	1.2	
RGB Max. Output Level	Vmx	_	(Note T ₂₉)	6.85	7.15	7.45	V
Halftone Ys Level	Vthtl	_	(Note T ₃₀)	0.7	0.9	1.1	
Halftone Gain 1	G3htl3	_	(Note T ₃₁)	-4.5	-3.0	-1.5	٦D
Halftone Gain 2	G6htl3	_	(Note T ₃₂)	-7.5	-6.0	-4.5	dB
Text ON Ys Level	Vttxl	_	(Note T ₃₃)	1.8	2.0	2.2	
Text / OSD Output, Low Level	VtxI13	_	(Note T ₃₄)	-0.45	-0.25	-0.05	
Text RGB Output, High Level	Vmt13	_	(Note T ₃₅)	1.15	1.4	1.85	
OSD Ys ON Level	Vtosl	_	(Note T ₃₆)	2.8	3.0	3.2	V
OSD RGB Output, High Level	Vmos13	_	(Note T ₃₇)	1.75	2.15	2.55	
Text Input Threshold Level	Vtxtg	_	(Note T ₃₈)	0.7	1.0	1.3	
OSD Input Threshold Level	Vosdg	_	(Note T ₃₉)	1.7	2.0	2.3	

CHARACTERISTIC	SYMBOL	TEST CIR- CUIT	TEST CONDITION	MIN	TYP.	MAX	UNIT
	T _{Rosr}	_					
OSD Mode Switching Rise-Up Time	T _{Rosg}	_	(Note T ₄₀)	_	40	100	ns
	T _{Rosb}	_					
	t _{PRosr}	_					
OSD Mode Switching Rise-Up Transfer Time	t _{PRosg}	_	(Note T ₄₁)	_	40	100	ns
	t _{PRosb}	_					
OSD Mode Switching Rise-Up Transfer Time, 3 Axes Difference	Δt _{PRos}	_	(Note T ₄₂)	_	15	40	ns
	T _{Fosr}	_					
OSD Mode Switching Breaking Time	T _{Fosg}	_	(Note T ₄₃)	_	30	100	ns
	T _{Fosb}	_					
	t _{PFosr}	_					
OSD Mode Switching Breaking Transfer Time	t _{PFosg}	_	(Note T ₄₄)	_	30	100	ns
	t _{PFosb}	_					
OSD Mode Switching Breaking Transfer Time, 3 Axes Difference	Δt _{FRos}	_	(Note T ₄₅)	_	20	40	ns
	TRoshr	_					
OSD Hi DC Switching Rise-Up Time	TRoshg	_	(Note T ₄₆)	_	20	100	ns
	TRoshb	_					
	t _{PRohr}	_					
OSD Hi DC Switching Rise-Up Transfer Time	t _{PRohg}	_	(Note T ₄₇)	_	20	100	ns
	t _{PRohb}	_					
OSD Hi DC Switching Rise-Up Transfer Time, 3 Axes Difference	Δt_{PRoh}	_	(Note T ₄₈)	_	0	40	ns
	TFoshr	_					
OSD Hi DC Switching Breaking Time	TFoshg	_	(Note T ₄₉)	_	20	100	ns
	TFoshb						
	t _{PFohr}						
OSD Hi DC Switching Breaking Transfer Time	t _{PFohg}		(Note T ₅₀)	_	20	100	ns
	t _{PFohb}	_					
OSD Hi DC Switching Breaking Transfer Time, 3 Axes Difference	Δt_{PFoh}	_	(Note T ₅₁)	_	0	40	ns

CHARACTERISTIC	SYMBOL	TEST CIR- CUIT	TEST CONDITION	MIN	TYP.	MAX	UNIT
	Vc12mx	_		2.10	2.5	2.97	
	Vc12mn	_		0.21	0.31	0.47	
	D12c80	_		0.84	1.25	1.87	
	Vc13mx	_		2.10	2.5	2.97	
RGB Contrast Control Characteristic	Vc13mn	_	(Note T ₅₂)	0.21	0.31	0.47	V
	D13c80	_		0.84	1.25	1.87	
	Vc14mx	_		2.10	2.5	2.97	
	Vc14mn	_		0.21	0.31	0.47	
	D14c80	_		0.84	1.25	1.87	
Analog RGB AC Gain	Gag	_	(Note T ₅₃)	4.0	5.1	6.3	times
Analog RGB Frequency Characteristic	Gfg	_	(Note T ₅₄)	-0.5	-1.75	-3.0	dB
Analog RGB Dynamic Range	Dr24	_	(Note T ₅₅)	0.5	_	_	
RGB Brightness Control	Vbrmxg	_	(Note T ₅₆)	3.05	3.25	3.45	.,
Characteristic	Vbrmng	_	(Note 156)	1.05	1.25	1.45	V
RGB Brightness Center Voltage	Vbcntg	_	(Note T ₅₇)	2.05	2.25	2.45	
RGB Brightness Data Sensitivity	ΔVbrtg	_	(Note T ₅₈)	6.3	7.8	9.4	mV
Analog RGB Mode ON Voltage	Vanath	_	(Note T ₅₉)	0.8	1.0	1.2	V
	TRanr	_					
Analog RGB Switching Rise-Up Time	TRang	_	(Note T ₆₀)	_	50	100	
	TRanb	_					
	t _{PRanr}	_					
Analog RGB Switching Rise-Up Transfer Time	t _{PRang}	_	(Note T ₆₁)	_	20	100	
	t _{PRanb}	_					
Analog RGB Switching Rise-Up Transfer Time, 3 Axes Difference	Δt _{PRas}	_	(Note T ₆₂)	_	0	40	ns
	TFanr	_					115
Analog RGB Switching Breaking Time	TFang	_	(Note T ₆₃)	_	50	100	
	TFanb	_					
	t _{PFanr}	_					
Analog RGB Switching Breaking Transfer Time	t _{PFang}	_	(Note T ₆₄)	_	30	100	
	t _{PFanb}	_					
Analog RGB Switching Breaking Transfer Time, 3 Axes Difference	Δt _{PFas}	_	(Note T ₆₅)	_	0	40	

CHARACTERISTIC	SYMBOL	TEST CIR- CUIT	TEST CONDITION	MIN	TYP.	MAX	UNIT	
	TRanhr	_						
Analog RGB Hi Switching Rise-Up Time	TRanhg	_	(Note T ₆₆)	_	50	100		
	TRanhb	_						
	t _{PRahr}	_						
Analog RGB Hi Switching Rise-Up Transfer Time	t _{PRahg}	_	(Note T ₆₇)	-	20	100		
	t _{PRahb}	_						
Analog RGB Hi Switching Rise-Up Transfer Time, 3 Axes Difference	Δt _{PRah}	_	(Note T ₆₈)	_	0	40	nc	
	t _{Fanhr}	_					ns	
Analog RGB Hi Switching Breaking Time	t _{Fanhg}	_	(Note T ₆₉)	_	50	100		
	t _{Fanhb}	_						
	t _{PFahr}	_						
Analog RGB Hi Switching Breaking Transfer Time	t _{PFahg}	_	(Note T ₇₀)	_	20	100		
	t _{PFahb}	_						
Analog RGB Hi Switching Breaking Transfer Time, 3 Axes Difference	Δt _{PFah}	_	(Note T ₇₁)	_	0	40		
TV-Analog RGB Crosstalk	Crtvag	_	(Note T ₇₂)	-80	-50	-40	dB	
Analog RGB-TV Crosstalk	Crantg	_	(Note T ₇₃)	-00	-50	-40	иь	
	Vablpl	_		5.5	5.6	5.7		
ABL Point Characteristic	Vablpc	_	(Note T ₇₄)	5.7	5.8	5.9	V	
	Vablph	_		5.9	6.0 6.1			
ACL Characteristic	Vcal	_	(Note T ₇₅)	-19	-16	-13	dB	
	Vabll	_		-0.3	0	0.3		
ABL Gain Characteristic	Vablc —		(Note T ₇₆)	-1.3	-1.0	-0.7	٧	
	Vablh	_		-2.3	-2.0	-1.7		

CHARACTERISTIC	SYMBOL	TEST CIR-	TEST CONDITION	MIN	TYP.	MAX	UNIT
		CUIT					
Bell Monitor Output Amplitude	embo	_	(Note S ₁)	200	300	400	mV _{p-p}
Bell Filter fo	foB-C	_	(Note S ₂)	-23	0	23	
Bell Filter f₀ Variable Range	foB-L		(Note S ₃)	-69	- 46	-23	kHz
Dell'i liter 16 variable rearige	foB-H		(14016-03)	69	92	115	
Bell Filter Q	QBEL	_	(Note S ₄)	14	16	18	_
Color Difference Output Amplitude	VBS	_	(Note S ₅)	0.50	_	0.91	V _{p-p}
Golor Billerence Gutput Amplitude	VRS		(14016-05)	0.39	_	0.73	v p-p
Color Difference Relative Amplitude	R/B-S	_	(Note S ₆)	0.70	_	0.90	_
Color Difference Attenuation Quantity	SATTB	_	(Note S ₇)	-1.50		-0.50	
Color Difference Attenuation Quantity	SATTR	_	(Note 37)	-1.50	_	-0.50	dB
Color Difference S / N Ratio	SNB-S	_	(Note S ₈)	-85		-25	ub
Color Difference 37 N Natio	SBR-S		(11016-08)	05		25	
Linearity	LinB	_	(Note S ₉)	75	_	117	- %
Linearity	LinR	_	(Note 39)	85	_	120	/0
Rising-Fall Time	trfB	_	(Note S ₁₀)		1.3	1.5	
(Standard De-Emphasis)	trfR		(Note 3 ₁₀)	_	1.5	1.5	
Rising-Fall Time	trfBw	_	(Note S ₁₁)		1.1	1.3	μs
(Wide-Band De-Emphasis)	trfRw		(Note 311)		1.1	1.5	
Killer Operation Input Level	eSK	_	(Note S ₁₂)				
(Standard Setting)	eSC		(Note 3 ₁₂)	0.5	1	2	
Killer Operation Input Level	eSFK	_	(Note S ₁₃)	0.5	'		mV _{p-p}
(VID ON)	eSFC	_	(14016-313)				′′′∨р-р
Killer Operation Input Level	eSWK	_	(Note S ₁₄)	0.7	1.5	3	
(Low Sensitivity, VID OFF)	eSWC	_	(Note 314)	0.7	1.0		

TEST CONDITION VIDEO SECTION

					TEST	COND	ITION	(Unles	s othe	rwise s	specifie	d : H,	, RGB V _{CC} = 9V ; V _{DD} , Fsc V _{DD} , Y / C V _{CC} = 5V ; Ta = 25±3°C)
NOTE	ITEM	•		W MOD							JS DA		MEASURING METHOD
-		S ₃₉	S ₄₂	S ₄₄	S ₄₅	S ₅₁	04H	H80	0FH	10H	13H	14H	
	V Innut Dadastal												(1) Short circuit pin 45 (Y ₁ IN) in AC coupling.
Y ₁	Y Input Pedestal Clamping Voltage	Α	С	В	Α	Α	20H	04H	80H	00H	BAH	03H	(2) Input synchronizing signal to pin 51 (SYNC IN).
	. 0												(3) Measure DC voltage at pin 45, and express the measurement result as VYclp.
													(1) Set the 358 TRAP mode to AUTO by setting the bus data.
													(2) Set the bus data so that chroma trap is ON and f_0 is 0.
\ \ \	Chroma Trap												(3) Input TG7 sine wave signal whose frequency is 3.58MHz (NTSC) and video amplitude is 0.5V to pin 45 (Y ₁ IN).
Y ₂	Frequency	Î	Î	A	В	Î	1	Î	Î	1	Î	Î	(4) While observing waveform at pin 37 (Y _{1out}), find a frequency with minimum amplitude of the waveform. The obtained frequency shall be expressed as flr3.
													(5) Change the frequency of the signal 1 to 4.43MHz (PAL) and perform the same measurement as the preceding step 4. The obtained frequency shall be expressed as flr4.
													(1) Set the 358 TRAP mode to AUTO by setting bus data.
													(2) Set the bus data so that Q of chroma trap is 1.5.
													(3) Set the bus data so that f ₀ of chroma trap is 0.
													(4) Input TG7 sine wave signal whose frequency is 3.58MHz (NTSC) and video amplitude is 0.5V to pin 45 (Y ₁ IN).
Y ₃	Chroma Trap Attenuation (3.58MHz)	↑	1	1	1	1	1	1	Vari- able	Vari- able	Vari- able	↑	(5) While turning on and off the chroma trap by controlling the bus, measure chroma amplitude (VTon) at pin 37 (Y _{1out}) with the chroma trap being turned on and measure chroma amplitude (VToff) at pin 37 (Y _{1out}) with the chroma trap being turned off. Gtr = 20log (VToff / VTon)
													(6) Change f ₀ of the chroma trap to −100kHz, −50kHz, 0 and +50kHz, and perform the same measurement as the preceding steps 4 and 5 with the respective f ₀ settings.
													(7) Change Q of the chroma trap t 1, 1.5, 2 and 2.5, and perform the same measurement as the preceding steps 4 through 6. The maximum Gtr shall be expressed as Gtr3a.
													(8) Set the 358 TRAP mode to the forces 358 mode by setting bus data, and perform the same measurement as the preceding steps 2 through 7 (Gtr3f).

					TEST	COND							RGB V _{CC} = 9V ; V _{DD} , Fsc V _{DD} , Y / C V _{CC} = 5V ; Ta = 25±3°C)
NOTE	ITEM			W MOD				JB-AD					MEASURING METHOD
		S ₃₉	S ₄₂	S ₄₄	S ₄₅	S ₅₁	04H	H80	0FH	10H	13H	14H	
													(1) Set the 358 TRAP mode to AUTO by setting bus data.
													(2) Set the bus data so that Q of chroma trap is 1.5.
.,	Chroma Trap								Vari-	Vari-	Vari-		(3) Set the bus data so that f ₀ of chroma trap is 0.
Y ₄	Attenuation (4.43MHz)	Α	С	Α	В	Α	20H	04H	able			03H	(4) Input TG7 sine wave signal whose frequency is 4.43MHz and video amplitude is 0.5V to pin 45 (Y ₁ IN).
													(5) Perform the same measurement as the steps 5 through 7 of the preceding item Y ₃ . The measurement result shall be expressed as Gtr4.
													(1) Set the bus data so that the 358 TRAP mode is AUTO and the Dtrap is ON.
													(2) Set the bus data so that Q of chroma trap is 1.5.
Y ₅	Chroma Trap	↑	↑	↑	↑	^	↑	↑	1		↑	1	(3) Set the bus data so that f ₀ of chroma trap is 0.
1.5	Attenuation (SECAM)	'	'	'	'	'	'	'	'	'	'	'	(4) Input SECAM signal whose amplitude in video period is 0.5V to pin 45 (Y ₁ IN).
													(5) Perform the same measurement as the steps 5 through 7 of the preceding item Y ₃ to find the maximum attenuation (Gtrs).
													(1) Connect the power supply to pin 45 (Y ₁ IN).
													(2) Turn off Y_{γ} by setting the bus data.
Y ₆	Yy Correction Point	•	^	•	^	*	*	Vari-	80H	001	ВАН	•	(3) While raising the supply voltage from the level measured in the preceding item Y ₁ , measure voltage change characteristic of Y ₁ output at pin 37.
16	ry Correction Point	I	ı		I		'	able	оип	ООП	БАП		(4) Set the bus data to turn on Y _γ .
													(5) Perform the same measurement as the above step 3.
													(6) Find a gamma (_γ) point from the measurement results of the steps 3 and 5. γp = Vr÷0.7V
Y ₇	Yγ Correction Curve	1	1	1	1	1	1	1	1	1	1	1	From the measurement in the above item Y_6 , find gain of the portion that the γ correction has an effect on.

						COND							RGB V _{CC} = 9V ; V _{DD} , Fsc V _{DD} , Y / C V _{CC} = 5V ; Ta = 25±3°C)
NOTE	ITEM			W MOD				JB-AD					MEASURING METHOD
		S ₃₉	S ₄₂	S ₄₄	S ₄₅	S ₅₁	04H	H80	0FH	10H	13H	14H	
													(1) Short circuit pin 45 (Y ₁ IN) in AC coupling.
													(2) Input synchronizing signal to pin 51.
Y ₈	APL Terminal Output Impedance	Α	С	В	А	А	20H	04H	80H	00H	ВАН	03H	(3) Connect power supply and an ammeter to the APL of pin 44 as shown in the figure, and adjust the power supply so that the ammeter reads 0 (zero).
													(4) Raise the voltage at pin 44 by 0.1V, and measure the current (lin) at that time. Zo44 (Ω) = 0.1V÷lin (A)
													(1) Set the bus data so that DC transmission factor correction gain is maximum.
													(2) In the condition of the Note Y ₈ , observe Y _{1out} waveform at pin 37 and measure voltage change in the video period.
	DC Transmission												(3) Set the bus data so that DC transmission factor correction gain is centered, and measure voltage in the same manner as the above step 2.
Y ₉	Compensation Amplifier Gain	1	1	1	1	1	1	↑	1	1	1	Vari- able	Pin 19 waveform ΔV_1 Pin 44 + 0.1V ΔV_2 Pin 44 + 0.2V
													$Adr = (\Delta V_2 - \Delta V_1) \div 0.1V \div Y_1 \text{ gain}$
													(1) Set the bus data so that black expansion is on and black expansion point is maximum.
	Maximorma Cain of Distric												(2) Input TG7 sine wave signal whose frequency is 500kHz and video amplitude is 0.1V to pin 45 (Y ₁ IN).
Y ₁₀	Maximum Gain of Black Expansion Amplifier	↑	1	Α	В	1	1	1	00H	1	1	E3H	(3) While impressing 1.0V to pin 39 (Black Peak Hold), measure amplitude (Va) of Y _{1out} signal at pin 37.
													(4) While impressing 3.5V to pin 39 (Black Peak Hold), measure amplitude (Vb) of Y _{1out} signal at pin 37. Akc = Va÷Vb

					TEST	COND	ITION	(Unles	s othe	rwise s	specifie	ed : H,	RGB V _{CC} = 9V ; V _{DD} , Fsc V _{DD} , Y / C V _{CC} = 5V ; Ta = 25±3°C)
NOTE	ITEM			W MOD				JB-AD					MEASURING METHOD
		S ₃₉	S ₄₂	S ₄₄	S ₄₅	S ₅₁	04H	H80	0FH	10H	13H	14H	
													 Set the bus data so that black expansion is on and black expansion point is maximum.
													(2) Supply 1.0V to pin 39 (Black Peak Hold).
													(3) Supply 2.9V to the APL of pin 44.
Y ₁₁	Black Expansion Start	A	С	A	A	A	20H	04H	00H	00H	ВАН	Vari- able	(4) Connect the power supply to pin 45 (Y1 IN). While raising the supply voltage from the level measured in the preceding item Y1, measure voltage change at pin 37 (Y1out).
	Folit											able	(5) Set the bus data to center the black expansion point, and perform the same measurement as the above steps 2 through 4. Black expansion OFF ON Pin 45
													(6) Set the black expansion point to the minimum by setting the bus data, and perform the same measurement as the above steps 2 through 4.
													(7) While supplying 2.2V to the APL of pin 44, perform the same measurement as the above step 4 with the black expansion point set to maximum, center and minimum.
													In the condition of the Note Y_1 , measure waveform at pin 39 (Black Peak Hold).
Y ₁₂	Black Peak Detection Period (Horizontal) Black Peak Detection Period (Vertical)	В	†	1	1	†	1	↑	1	1	1	ЕЗН	→ TbpH TbpV

					TEST	COND	ITION	(Unles	s othe	rwise	specific	ed : H,	RGB V _{CC} = 9V ; V _{DD} , Fsc V _{DD} , Y / C V _{CC} = 5V ; Ta = 25±3°C)
NOTE	ITEM			W MOD	E		Sl	JB-AD	DRES	S & Bl	JS DA	TA	MEASURING METHOD
		S ₃₉	S ₄₂	S ₄₄	S ₄₅	S ₅₁	04H	H80	0FH	10H	13H	14H	
													(1) Set the bus data so that picture quality control frequency is 2.5MHz.
													(2) Input TG7 sine wave (sweeper) signal whose video level is 0.1V to pin 45 (Y ₁ IN) and pin 51 (Sync. IN).
\ \ \	Picture Quality Control				_		٥٥٠١	0411	0011	0011	DALL	Vari-	(3) Maximize the picture quality control data.
Y ₁₃	Peaking Frequency	А	С	Α	В	А	3FH	04H	80H	00H	BAH	able	(4) While observing Y _{1out} of pin 37, find an SG frequency as the waveform amplitude is maximum (fp25).
													(5) Set the bus data so that picture quality control frequency is 3.1MHz and 4.2MHz, and perform the same measurement as the above steps 2 through 4 at the respective frequencies (fp31, fp42).
													(1) Input TG7 sine wave (sweeper) signal whose video level is 0.1V to pin 45 (Y ₁ IN) and pin 51 (Sync. IN).
													(2) Set the picture quality control data to maximum.
													(3) Set the picture quality control frequency is 2.5MHz by setting the bus data.
	Picture Quality Control												(4) Measure amplitude (V100k) of the output of pin 37 (Y ₁ OUT) as the SG frequency is 100kHz, and the amplitude (Vp25) of the same as the SG frequency is 2.5MHz. GS25MX = 20log (Vp25 / V100k)
Y ₁₄	Maximum Characteristic	1	1	1	1	1	1	1	1	1	1	1	(5) Set the picture quality control frequency data to 3.1MHz by setting the bus data.
	Characteristic												(6) Measure amplitude (V100k) of the output of pin 37 (Y ₁ OUT) as the SG frequency is 100kHz, and the amplitude (Vp31) of the same as the SG frequency is 3.1MHz. GS31MX = 20log (Vp31 / V100k)
													(7) Set the picture quality control frequency to 4.2MHz by setting the bus data.
													(8) Measure amplitude (V100k) of the output of pin 37 (Y ₁ OUT) as the SG frequency is 100kHz, and the amplitude (Vp42) of the same as the SG frequency is 4.2MHz. GS42MX = 20log (Vp42 / V100k)

						COND							RGB V _{CC} = 9V ; V _{DD} , Fsc V _{DD} , Y / C V _{CC} = 5V ; Ta = 25±3°C)
NOTE	ITEM			W MOD						S & BL			MEASURING METHOD
		S ₃₉	S ₄₂	S ₄₄	S ₄₅	S ₅₁	04H	08H	0FH	10H	13H	14H	ME ROSTATO METTOS
Y ₁₅	Picture Quality Control Minimum Characteristic	А	С	Α	В	А	00H	04H	80H	00H	ВАН	Vari- able	 In the condition of the Note Y₁₄, set the picture quality control bus data to minimum. Perform the same measurement as the steps 3 through 8 of the Note Y₁₄ to find respective gains as the picture quality control frequency is set to 2.5MHz, 3.1MHz and 4.2MHz.
	Cital acteristic												GS25MN = 20log (Vp25 / V100k) GS31MN = 20log (Vp31 / V100k) GS42MN = 20log (Vp42 / V100k)
													(1) In the condition of the Note Y ₁₄ , set the picture quality control bus data to center.
Y ₁₆	Picture Quality Control Center Characteristic	1	↑	↑	1	1	20H	↑	↑	†	1	↑	(2) Perform the same measurement as the steps 3 through 8 of the Note Y ₁₄ to find respective gains as the picture quality control frequency is set to 2.5MHz, 3.1MHz and4.2MHz. GS25CT = 20log (Vp25 / V100k) GS31CT = 20log (Vp31 / V100k) GS42CT = 20log (Vp42 / V100k)
													(1) Set the bus data so that black expansion is off, picture quality control is off and DC transmission compensation is minimum.
Y ₁₇	Y Signal Gain	1	↑	\uparrow	1	1	1	1	1	1	1	03H	(2) Input TG7 sine wave signal whose frequency is 100kHz and video level is 0.5V to pin 45 (Y ₁ IN) and pin 51 (Sync. IN). (Vyi100)
													(3) Measure amplitude of Y ₁ output at pin 37 (Vyout). Gy = 20log (Vyout / Vyi100)
													(1) Set the bus data so that black expansion is off, picture quality control is off and DC transmission compensation is minimum.
V	Y Signal Frequency	•	•	•	•		•				•		(2) Input TG7 sine wave signal whose frequency is 6MHz and video level is 0.5V to pin 45 (Y ₁ IN) and pin 51 (Sync. IN). (Vyi6M)
Y ₁₈	Characteristic		ı	ı	ı		1		1	1	I		(3) Measure amplitude of Y ₁ output at pin 37 (Vyo6M). Gy6M = 20log (Vyo6M / Vyi6M)
													(4) Find Gfy from the result of the Note Y ₁₇ . Gfy = Gy6M - Gy

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					TEST	COND	ITION	(Unles	s othe	rwise s	specifie	ed : H,	RGE	3 V _{CC} = 9V ; V _{DD} , Fsc V _{DD} , Y / C V _{CC} = 5V ; Ta = 25±3°C)
NOTE	ITEM		S	W MOD)E		SI	JB-AD	DRES	S & Bl	JS DA	ГА		MEASURING METHOD
		S ₃₉	S ₄₂	S ₄₄	S ₄₅	S ₅₁	04H	08H	0FH	10H	13H	14H		WEAGONING WE ITIOD
													(1)	Set the bus data so that black expansion is off, picture quality control is off and DC transmission compensation is minimum.
Y ₁₉	Y Signal Maximum Input Range	Α	С	Α	В	Α	20H	04H	80H	00H	BAH	03H	(2)	Input TG7 sine wave signal whose frequency is 100kHz to pin 45 (Y $_{\!1}$ IN) and pin 51 (Sync. IN).
													(3)	While increasing the amplitude Vyd of the signal in the video period, measure Vyd just before the waveform of Y_1 output (pin 37) is distorted.

TOSHIBA

NOTE	ITEM				T		NDITION	V (Unles	s other	wise spe	cified : I	H, RGB V _{CC} = 9V ; V _{DD} , Fsc V _{DD} , Y / C V _{CC} = 5V ; Ta = 25±3°C)
NOTE	TTEW!	S ₂₆	S ₁	S ₃₁	S ₃₃	S ₃₄	_	S ₄₂	S ₄₄	S ₄₅	S ₅₁	MEASURING METHOD
												(1) Activate the test mode (S26-ON, Sub Add 02; 01h).
												(2) Set as follows: band pass filter Q = 2, f ₀ = 600kHz, crystal clock = conforming to European, Asian system.
												(3) Set the gate to the normal status.
												(4) Input 3N rainbow color bar signal to pin 42 (Chroma IN).
	ACC											(5) When input signal to pin 42 is the same in the burst and chroma levels (10mV _{p-p}), burst amplitude of B-Y output signal from pin 36 is expressed as eAT. When the level of input signal to pin 42 is 100mV _{p-p} or 300mV _{p-p} , burst amplitude of the B-Y output signal is expressed as F1T or F2T. The ratio between F1T and F2T is expressed as AT. F2T / F1T = AT
C ₁	Characteristic	ON	A	В	В	В	A	A	A	A	В	(6) Perform the same measurement in the EXT. mode (f ₀ = 0). (eAE, F1E, AE) Pin 36 B-Y burst amplitude 10 100 300 Pin 42 Chroma burst
												(7) Input 4N rainbow color bar signal to pin 42 (Chroma IN), and perform the same measurement as the above-mentioned steps with 3N rainbow color bar signal input.

NOTE	ITEM				TE	ST COI		N (Unles	s otherv	vise spe	cified : I	H, RGB V _{CC} = 9V ; V _{DD} , Fsc V _{DD} , Y / C V _{CC} = 5V ; Ta = 25±3°C)
11012		S ₂₆	S ₁	S ₃₁	S ₃₃	S ₃₄	S ₃₉	S ₄₂	S ₄₄	S ₄₅	S ₅₁	MEASURING METHOD
												(1) Activate the test mode (S26-ON, Sub Add 02; 01h).
												(2) Set as follows: band pass filter Q = 2, crystal clock = conforming to 3.579 / 4.43MHz, gate = normal status.
												(3) Input 3N composite sine wave signal (1V _{p-p}) to pin 42 (Chroma IN).
												(4) Measure frequency characteristic of B-Y output of pin 36 and measure the peak frequency, too.
												(5) Changing f ₀ to 0, 500, 600 and 700 by the bus control and measure peak frequencies respectively with different f ₀ .
('0	Band Pass Filter Characteristic	ON	Α	В	В	В	Α	В	Α	A	В	(6) For measuring frequency characteristic as f _o is 4.43, use 4.43MHz crystal clock Measure the following items in the same manner.
	Gilaracteristic											Peak of frequency Bottom of frequency Pin 42 sine wave signal Fig. = 4.43 Peak of frequency Fig. = 4.43 Peak of frequency frequency Pin 42 sine wave signal

					TE			V (Unles	s otherv	vise spe	cified : F	H, RGB V _{CC} = 9V ; V _{DD} , Fsc V _{DD} , Y / C V _{CC} = 5V ; Ta = 25±3°C)
NOTE	ITEM	S ₂₆	S ₁	S ₃₁	S ₃₃	SW N	S ₃₉	S ₄₂	S ₄₄	S ₄₅	S ₅₁	MEASURING METHOD
				U,				'-		10	U I	(1) Activate the test mode (S26-ON, Sub Add 02; 01h).
												(2) Set as follows: band pass filter Q = 2, crystal clock = conforming to 3.579 / 4.43MHz.
												(3) Set the gate to the normal status.
												(4) Input 3N composite sine wave signal (1V _{p-p}) to pin 42 (Chroma IN).
	Band Pass Filter,											(5) Measure frequency characteristic of B-Y output of pin 36, and measure peak frequency in the −3dB band.
C ₃	-3dB Band Characteristic	ON	Α	В	В	В	Α	В	Α	Α	В	(6) Changing f _o to 0, 500, 600 and 700 by the bus control and measure peak frequencies in the −3dB band respectively with different f _o .
												Pin 36 Pin 36 Pin 42 sine wave signal $f_0 = 4.43$ Pin 42 sine wave signal
C ₄	Band Pass Filter, Q Characteristic Check	1	1	1	î	1	Î	1	1	1	1	 (1) Activate the test mode (S26-ON, Sub Add 02; 01h). (2) Set as follows: TV mode (f₀ = 600), Crystal mode = conforming to 3.579 / 4.43MHz, gate = normal status. (3) Input 3N composite sine wave signal (1V_{p-p}) to pin 42 (Chroma IN). (4) Measure frequency characteristic of B-Y output of pin 36, and measure peak frequency in the -3dB band. (5) Changing f₀ of the band pass filter to 0, 500, 600 and 700 by the bus control and measure peak frequencies in the -3dB band respectively with different f₀. f₀ = 3.58 Pin 36 Pin 36 Pin 36 Pin 42 sine wave signal

					T	EST CO	NDITION	N (Unles	s otherv	vise spe	cified : F	I, RGB $V_{CC} = 9V$; V_{DD} , Fsc V_{DD} , Y / C $V_{CC} = 5V$; Ta = 25±3°C)
NOTE	ITEM						JODE					MEASURING METHOD
		S ₂₆	S ₁	S ₃₁	S ₃₃	S ₃₄	S ₃₉	S ₄₂	S ₄₄	S ₄₅	S ₅₁	WE TOOT THE THOS
C ₅	1 / 2 f ₀ Trap Characteristic	ON	S ₁	В В	В В	В В	S ₃₉	S ₄₂	A	S ₄₅	S ₅₁	 (1) Activate the test mode (S26-ON, Sub Add 02; 01h). (2) Set as follows: band pass filter Q = 2, crystal clock = conforming to 3.579 / 4.43MHz, gate = normal status. (3) Input 3N composite sine wave signal (1V_{p-p}) to pin 42 (Chroma IN). (4) Measure frequency characteristic of B-Y output of pin 36, and measure bottom frequency. (5) Changing f₀ to 0, 500, 600 and 700 by the bus control and measure bottom frequencies respectively with different f₀. f₀ = 3.58 Pin 36 Pin 36
												Bottom Pin 42 sine Bottom Pin 42 sine freq. wave signal freq. wave signal

					TE			l (Unles	s otherw	vise spe	cified : F	I, RG	SB V _{CC} = 9V ; V _{DD} , Fsc V _{DD} , Y / C V _{CC} = 5V ; Ta = 25±3°C)
NOTE	ITEM	S ₂₆	S ₁	S ₃₁	S ₃₃	SW N	1ODE S ₃₉	S ₄₂	S ₄₄	S ₄₅	S ₅₁	1	MEASURING METHOD
												(1)	Activate the test mode (S26-ON, Sub Add 02; 08h).
												(2)	Connect band pass filter (Q = 2), set crystal mode to conform to European, Asian system and set the gate to normal status.
												(3)	Input 3N rainbow color bar signal ($100 \text{mV}_{\text{p-p}}$) to pin 42 (Chroma IN).
C ₆	Tint Control Sharing Range	ON	Α	В	В	В	Α	Α	Α	Α	В	(4)	Measure phase shift of B-Y color difference output of pin 36.
	$(f_0 = 600kHz)$											(5)	While shifting color phase (tint) from minimum to maximum by the bus control, measure phase change of B-Y color difference output of pin 36. On the condition that 6 bars in the center have the peak level (regarded as center of color phase), the side of 5 bars is regarded as positive direction while the side of 7 bars is regarded as negative direction
													when the 5 bars or the 7 bars are in the peak level. Based on this assumption, open angle toward the positive direction is expressed as $\Delta\theta_1$ and that
													toward the negative direction is expressed as $\Delta\theta_2$ as viewed from the phase center. $\Delta\theta_1$ and $\Delta\theta_2$ show the tint control sharing range.
C ₇	Tint Control Variable Range	<u> </u>	<u></u>	1	↑	↑	↑	↑	↑	+	↑	(6)	Variable range is expressed by sum of $\Delta\theta_1$ sharing range and $\Delta\theta_2$ sharing range.
	$(f_0 = 600kHz)$	'	'		'	'	'	1	'		'		$\Delta\theta_{T} = \Delta\theta_1 + \Delta\theta_2$
												(7)	While shifting color phase from minimum to maximum with the bus control, measure phase shift of B-Y color difference output of pin 36. When center 6 bars have peak level, value of color phase bus step is expressed as θ_{Tin} .
												(8)	While shifting color phase from minimum to maximum with the bus control, measure values of color phase bus step corresponding to 10% and 90% of absolutely variable
C ₈	Tint Control Characteristic	1	1	1	↑	1	↑	↑	1	1	1		phase shift of B-Y color difference output of pin36. The range of color phase shifted by the bus control is expressed as While shifting color phase from minimum to maximum with the bus control, measure phase shift of B-Y color difference output of pin 36. When center 6 bars have peak level, value of color phase bus step is expressed as Δ_{Tin} (conforming to TV mode, f_0 = 600kHz).
												(9)	Input 4N rainbow color bar signal to pin 42 (Chroma IN), and perform the same measurement as the 3N signal.

					TE			V (Unles	s otherw	ise spe	cified : F	, RGB V _{CC} = 9V ; V _{DD} , Fsc V _{DD} , Y / C V _{CC} = 5V ; Ta = 25±3°C)
NOTE	ITEM	S ₂₆	S ₁	S ₃₁	S ₃₃	SW N	S ₃₉	S ₄₂	S44	S ₄₅	S ₅₁	MEASURING METHOD
			•			V	O.			·	J.	(1) Connect band pass filter (Q = 2), set to TV mode (f ₀ = 600kHz) with X'tal clock conforming to European, Asian system.
												(2) Set the gate to normal status.
												(3) Input 3N CW signal of 100mV _{p-p} to pin 42 of the chroma input terminal.
												(4) While changing frequency of the CW (continuous waveform) signal, measure its frequency when B-Y color difference signal of pin 36 is colored.
												(5) Input 4N CW (continuous waveform) 100mV _{p-p} signal to pin 42 (Chroma IN).
C ₉	APC Lead-In Range	OFF ↓	Α	В	В	В	Α	A ↓	А	Α	В	(6) While changing frequency of the CW signal, measure frequencies when B-Y color difference output of pin 36 is colored and discolored. Find difference between the measured frequency and f _C (4.433619MHz) and express the differences as fPH and fPL, which show the APC lead-in range.
		ON						С				(7) Variable frequency of VCXO is used to cope with lead-in of 3.582MHz / 3.575MHz PAL system.
												(8) Activate the test mode (S26-ON, Sub Add 02; 02h).
												(9) Input nothing to pin 42 (Chroma IN).
												(10) While varying voltage of pin 30 (APC Filter), measure variable frequency of VCXO at pin 35 (R-Y OUT) while observing color and discoloring of R-Y color difference signal. Express difference between the high frequency (fH) and f ₀ center as 3.582HH, and difference between the low frequency (fL) and f ₀ center as 3.582HL. Perform the same measurement for the NP system (3.575MHz PAL).
												(1) Activate the test mode (S26-ON, Sub Add 02; 02h).
												(2) Connect band pass filter as same as the Note C ₉ .
												(3) Change the X'tal mode properly to the system.
C ₁₀	APC Control Sensitivity	ON	↑	1	1	↑	↑	С	1	↑	↑	(4) Input nothing to pin 42 (Chroma IN).
	Gensilivity											(5) When V ₃₀ 's APC voltage ±50mV is impressed to pin 30 (APC Filter) while its voltage is being varied, measure frequency change of pin 35 output signal as frH or frL and calculate sensitivity according to the following equation.
												b = (frH - frL) / 100

					TE			V (Unles	s otherv	vise spe	cified : I	H, RGB V _{CC} = 9V ; V _{DD} , Fsc V _{DD} , Y / C V _{CC} = 5V ; Ta = 25±3°C)
NOTE	ITEM	S26	S ₁	S ₃₁	S33	SW N	ODE S ₃₉	S42	S ₄₄	S ₄₅	S ₅₁	MEASURING METHOD
C ₁₁	Killer Operation Input Level	OFF	S ₁	S ₃₁	В В	S ₃₄	S ₃₉	S ₄₂	A A	A A	S ₅₁	 (1) Connect band pass filter (Q = 2) and set to TV mode (f₀ = 600kHz). (2) Set the crystal mode to conform to European, Asian system and set the gate to normal status. (3) Input 3N color signal having 200mV_{p-p} burst to pin 42 (Chroma IN). (4) While attenuating chroma input signal, measure input burst amplitudes of the signal when B-Y color difference output of pin 36 is discolored and when the same signal is colored. Measured input burst amplitudes shall be expressed as 3N-VTK1 and 3N-VTC1 respectively (killer operation input level). (5) Killer operation input level in the condition that P / N killer sensitivity is set to LOW with the bus control is expressed as 3N-VTK2 or 3N-VTC2. (6) Perform the same measurement as the above step 4 with different inputs of 4N, 4P, MP, NP color signals having 200mV_{p-p} burst to pin 42 (Chroma IN). (When measuring with MP / NP color signal, set the crystal system to conform to South American system.) (7) Killer operation input level at that time is expressed as follows. Normal killer operation input level in the 4N system is expressed as 4P-VTK1, 4P-VTC1. Normal killer operation input level in the 4P system is expressed as 4P-VTK2, 4P-VTC2. Normal killer operation input level in the MP system is expressed as NP-VTK2, NP-VTC2. Normal killer operation input level in the NP system is expressed as NP-VTK1, NP-VTC1. Killer operation input level with low killer sensitivity is expressed as NP-VTK2, NP-VTC2. [Reference] 3N system : 3.579645MHz NTSC 4N system : 4.433619MHz False NTSC 4P system : 3.579641MHz M-PAL NP system : 3.582056MHz N-PAL NPAL

					TE			N (Unles	s otherv	vise spe	cified : F	I, RGB V _{CC} = 9V ; V _{DD} , Fsc V _{DD} , Y / C V _{CC} = 5V ; Ta = 25±3°C)
NOTE	ITEM	0				SW N			_			MEASURING METHOD
		S ₂₆	S ₁	S ₃₁	S ₃₃	S ₃₄	S ₃₉	S ₄₂	S ₄₄	S ₄₅	S ₅₁	
												(1) Activate the test mode (S26-ON, Sub Add 02; 08h).
												(2) Connect band pass filter (Q = 2), set to TV mode (f ₀ = 600kHz) with 0dB attenuation.
												(3) Set the crystal mode to conform to European, Asian system and set the gate to normal status.
C ₁₂	Color Difference	ON	Α	В	В	В	Α	Α	Α	A	В	(4) Input 3N, 4N and 4P rainbow color bar signals having 100mV _{p-p} burst to pin 42 of the chroma input terminal one after another.
312	Output	011	,,			5	,,	,,	,,			(5) Measure amplitudes of color difference signals of pin 36 (B-Y) and pin 35 (R-Y) respectively, and express them as 3NeB-Y / R-Y, 4NeB-Y / R-Y and 4PeB-Y / R-Y respectively.
												(6) While inputting 4P 75% color bar signal (100mV _{p-p} burst) to pin 42 of the chroma input terminal, measure amplitudes of color difference signals of pin 36 (B-Y OUT) and pin 35 (R-Y OUT) respectively. (Ratio of those amplitudes is expressed as 4Peb-y / r-y for checking color level of SECAM system.)
												(1) Activate the test mode (S26-ON, Sub Add 02; 08h).
												(2) Connect band pass filter (Q = 2), set to TV mode (f ₀ = 600kHz) with 0dB attenuation.
												(3) Set the crystal mode to conform to European, Asian system and set the gate to normal status.
C ₁₃	Demodulation Relative Amplitude	1	1	1	1	1	1	1	1	1	1	(4) Input 3N, 4N and 4P rainbow color bar signals having 100mV _{p-p} burst to pin 42 of the chroma input terminal one after another.
												(5) Measure amplitudes of color difference signals of pin 36 (B-Y) and pin 35 (R-Y) respectively, and express ratio between the two amplitudes as 3NG R / B, 4NG R / B and 4PG R / B respectively. (Note) Relative amplitude of G-Y color difference signal shall be checked later in the Text section.

NOTE	ITEM				TE			V (Unles	s otherv	vise spe	cified : F	RGB V _{CC} = 9V ; V _{DD} , Fsc V _{DD} , Y / C V _{CC} = 5V ; Ta = 25±3°C)
NOTE	ITEM	S ₂₆	S ₁	S ₃₁	S ₃₃	SW N	10DE S ₃₉	S ₄₂	S ₄₄	S ₄₅	S ₅₁	MEASURING METHOD
												(1) Activate the test mode (S26-ON, Sub Add 02; 08h).
												(2) Connect band pass filter (Q = 2), set to TV mode (f ₀ = 600kHz) with 0dB attenuation.
												(3) Set the crystal mode to conform to European, Asian system and set the gate to normal status.
C ₁₄	Demodulation	ON	Α	В	В	В	Α	Α	Α	A	В	(4) Input 3N, 4N and 4P rainbow color bar signals having 100mV _{p-p} burst to pin 42 of the chroma input terminal one after another.
014	Relative Phase	ON	Α			5	A	A	^			(5) Measure phases of color difference signals of pin 36 (B-Y) and pin 35 (R-Y) respectively, and express them as 3N0R-B, 4N0R-B and 4P0R-B respectively.
												(6) For measuring with 3N and 4N color bar signals in NTSC system, set six bars of the B-Y color difference waveform to the peak level with the Tint control and measure its phase difference from phase of R-Y color difference signal of pin 35 (R-Y OUT). (Note) Relative phase of G-Y color difference signal shall be checked later in the Text section.
												(1) Activate the test mode (S26-ON, Sub Add 02; 08h).
												(2) Connect band pass filter (Q = 2), set to TV mode (f ₀ = 600kHz) with 0dB attenuation.
												(3) Set the crystal mode to conform to European, Asian system.
C ₁₅	Demodulation Output Residual	1	↑	↑	↑	↑	↑	↑	↑	↑	↑	(4) Set the gate to normal status.
015	Carrier		1		'			1	1			(5) Input 3N and 4N rainbow color bar signals having 100mVp-p burst to pin 42 of the chroma input terminal one after another.
												(6) Measure subcarrier leak of 3N and 4N color bar signals appearing in color difference signals of pin 36 (B-Y OUT) and pin 35 (R-Y OUT) respectively, and express those leaks as 3N-SCB / R and 4N-SCB / R.

					TE			N (Unles	s otherv	vise spe	cified : I	f, RGB V _{CC} = 9V ; V _{DD} , Fsc V _{DD} , Y / C V _{CC} = 5V ; Ta = 25±3°C)
NOTE	ITEM					SW N	-					MEASURING METHOD
		S ₂₆	S ₁	S ₃₁	S ₃₃	S ₃₄	S ₃₉	S ₄₂	S ₄₄	S ₄₅	S ₅₁	
												(1) Activate the test mode (S26-ON, Sub Add 02; 08h).
												(2) Connect band pass filter (Q = 2), set to TV mode (f ₀ = 600kHz) with 0dB attenuation.
	Demodulation	011		_							_	(3) Set the crystal mode to conform to European, Asian system and set the gate to normal status.
C ₁₆	Output Residual Higher Harmonic	ON	Α	В	В	В	Α	А	А	A	В	(4) Input 3N and 4N rainbow color bar signals having 100mV _{p-p} burst to pin 42 of the chroma input terminal one after another.
												(5) Measure higher harmonic (2f _c = 7.16MHz or 8.87MHz) of 3N and 4N color bar signals appearing in color difference signals of pin 36 (B-Y OUT) and pin 35 (R-Y OUT) respectively, and express them as 3N-HCB / R and 4N-HCB / R.
												(1) Activate the test mode (S26-ON, Sub Add 02; 08h).
												(2) Connect band pass filter (Q = 2) and set bus data for the TV mode (f ₀ = 600kHz).
	Color Difference											(3) Set the X'tal clock mode to conform to European, Asian system and set the gate to normal status.
C ₁₇	Output ATT Check	↑	↑	1	1	1	1	1	1	1	1	(4) Input 3N rainbow color bar signal whose burst is 100mV _{p-p} to pin 42 of the chroma input terminal.
												(5) Measure amplitude of color difference output signal of pin 36 (B-Y OUT) with 0dB attenuation set by the bus control. Set the amplitude of the color difference output of pin 36 (B-Y OUT) to 0dB, and measure amplitude of the same signal with different attenuation of −2dB, −1dB and +1dB set by the bus control.

							TES	ST CC	DNDIT	ION	Unle	ss oth	erwise	e spe	cified	: H, RGB V _{CC} = 9V ; V _{DD}	, Fsc V _{DD} , Y / C V _{CC} = 5V ; Ta = 25±3°C)
NOTE	ITEM					TEST	MOD							RMAL	. CON	TROL MODE	
		S	_		2H	_	_	07H	_	_	_		H	_	_	OTHER CONDITION	MEASURING METHOD
-		26	D ₅	D ₂	D ₁	D ₀	D ₇	D ₄	D ₃	D ₅	D ₄	D ₃	D ₂	D ₁	D ₀		
																	(1) Input nothing to pin 42.
C ₁₈	16.2MHz Oscillation Frequency	ON	0	0	0	1	0	0	0	0	0	0	0	0	0	_	(2) Measure frequency of CW signal of pin 35 as fr, and find oscillation frequency by the following equation.
																	$\Delta foF = (fr - 0.05MHz) \times 4$
C ₁₉	16.2MHz Oscillation Start Voltage	ON	0	0	0	1	0	0	0	0	0	0	0	0	0	Impress pin 38 individually with separate power supply.	While raising voltage of pin 38, measure voltage when oscillation waveform appears at pin 40.
																	(1) Input nothing to pin 42.
C ₂₀	f _{sc} Free-Run	ON	0	0	0	1	0	0	0	0	١.	/ariabl	ما	0	0		(2) Change setting of SUB (10H) D ₄ , D ₃ and D ₂ according to respective frequency modes, and measure frequency of CW signal of pin 35.
C ₂₀	Frequency	ON	U	U		'	U	U	0		v	allabi	iC	0		_	Detail of D_4 , D_3 and D_2
																	3.58M = 1 : (001), 4.43M = 2 : (010)
																	M-PAL = 6 : (110), N-PAL = 7 : (111)
												1	1				(1) Input nothing to pin 42.
C ₂₁	f _{sc} Output Amplitude	OFF	0	0	0	0	0	0	0	0	0	0	↓ 0	0	0	ı	(2) Change setting of SUB (10H) D ₄ , D ₃ and D ₂ according to respective frequency modes. Measure the amplitude of output signal of pin 27.

DEF SECTION

NOTE	ITEM		SUE	3-ADD	Ĺ	nless S & B					TEST CONDITION I, RGB V _{CC} = 9V; V _{DD} , Fsc V _{DD} , Y / C V _{CC} = 5V; Ta = 25±3°C; BUS = preset value; pin 51 input video signal = 50 system (*x" in the data column represents preset value at power ON. MEASURING METHOD
DH1	H. Reference Frequency	Sub 02H	0	0	0	0	0	0	0	1	 (1) Supply 5V to pin 26. (2) Set bus data as indicated on the left. (3) Measure the frequency of sync. output of pin 49.
DH2	H. Reference Oscillation Start Voltage	Sub 02H	0	0	0	0	0	0	0	1	In the test condition of the Note DH1, turning down the voltage supplied to pin 26 from 5V, measure the voltage when oscillation of pin 49 stops.
DH3	H. Output Frequency 1	Sub 10H	×	×	×	×	×	×	0	1	(1) Set bus data as indicated on the left.(2) In the condition of the above step 1, measure frequency (TH1) at pin 4.
DH4	H. Output Frequency 2	Sub 10H	×	×	×	×	×	×	1	0	 Set the input video signal of pin 51 to the 60 system. Set bus data as indicated on the left. In the above-mentioned condition, measure frequency (TH2) at pin 4.
DH5	H. Output Duty 1	_	_	_	_	_	_	_	_	_	(1) Supply 4.5V DC to pin 5 (or, make pin 5 open-circuited).(2) Measure duty of pin 4 output.
DH6	H. Output Duty 2	_	_	_	_	_	_	_	_	_	(1) Make a short circuit between pin 5 and ground.(2) Measure duty of pin 4 output.
DH7	H. Output Duty Switching Voltage	_	_	_	_	_	_	_	_	_	Supply 2V DC to pin 5. While turning down the voltage from 2V, measure voltage when the output duty ratio becomes 41 to 37%.
DH8	H. Output Voltage	_	_	_	_	_	_	_	_	_	Measure the low voltage and high voltage of pin 4 output whose waveform is shown below.
DH9	H. Output Oscillation Start Voltage	_	_	_	_	_	_	_	_	_	While raising H. V _{CC} (pin 3) from 0V, measure voltage when pin 4 starts oscillation.

NOTE	ITEM				(U	nless	other	wise s		ied : H	TEST CONDITION I, RGB V _{CC} = 9V; V _{DD} , Fsc V _{DD} , Y / C V _{CC} = 5V; Ta = 25±3°C; BUS = preset value; pin 51 input video signal = 50 system "×" in the data column represents preset value at power ON.
			SU	B-ADD	RES	S & B	US D	ATA		(IVOLE	MEASURING METHOD
DH10	H. FBP Phase										(1) Supply 4.5V DC to pin 5.
											(2) Input video signal to pin 51.
											(3) Set the width of pin 6 input pulse to 8µs.
											(4) Measure φFBP shown in the figure below (φFBP).
DU11	H. Picture Position,										(5) Adjust the phase of pin 6 input pulse so that the center of pin 4's output pulse corresponds to the trailing edge of input sync. signal.
DHII	Maximum										(6) Set bus data as indicated on the left and measure the horizontal picture position with respective bus data settings (HSFTmax, HSFTmin).
											(7) Find HP difference between the conditions mentioned in the above step 6 (ΔHSFT).
											(8) Reset bus data to the preset value.
											(9) While impressing 5V DC to pin 5, measure HP.
DH12	H. Picture Position, Minimum										(10) While impressing 4V DC to pin 5, measure HP.
	Willimitati		0	0	0	0	0	×	×	×	(11) Find difference between the two measurement results obtained in the preceding steps 9 and 10 (ΔHCC).
DH13	H. Picture position Control Range	Sub 0BH	1	1	1	1	1	×	×	×	0.1μF 51) * μ - Video signal
	Control Nango										6
DH14	H. Distortion										(51) SYNC input
51114	Correction Control Range										6 Input
											4 Output

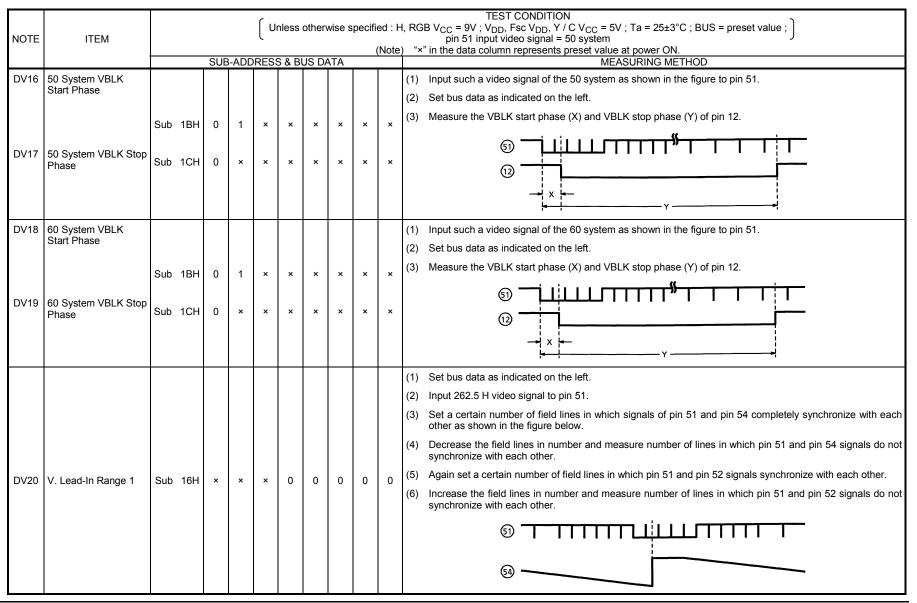
NOTE	ITEM				(U	nless	other	wise s				TEST CONDITION B V_{CC} = 9V ; V_{DD} , Fsc V_{DD} , Y / C V_{CC} = 5V ; Ta = 25±3°C ; BUS = preset value ; pin 51 input video signal = 50 system
			SUB	-ADD	RES	S & B	IS DA	ΔΤΔ		(Note) "×	" in the data column represents preset value at power ON. MEASURING METHOD
DH15	H. BLK Phase	Sub02H	0	0	0	0	0	1	0	0	(1)	In the condition of the steps 1 through 4 of the Note DH10, perform the following measurement.
	H. BLK Width,	00002	•								(2)	Supply 5V DC to pin 26.
	Minimum										(3)	Set bus data as indicated on the left.
											(4)	Measure phase difference between pin 51 and pin 49 as shown below.
			0	0	0	×	×	×	×	×	(5)	Change the bus data as shown on the left and measure BLK width.
DH17	H. BLK Width, Maximum	Sub 16H	1	1	1	×	×	×	×	×		(51) SYNC input
												4) Output BLK
DH18	P / N-GP Start Phase 1										(1)	Supply 5V to pin 26.
DUIAO	P / N-GP Start										(2)	Set bus data as indicated on the left.
פוחט	Phase 2										(3)	With the respective bus data settings mentioned above, measure the phase and gate width as shown in the figure below.
DH20	P / N-GP Gate Width 1	Sub 0FH	×	×	×	×	0	×	×	×		_ I I
DH21	P / N-GP Gate Width 2	Sub OFFI	×	×	×	×	1	×	×	×		§) ————————————————————————————————————
												SPGP1, 2 PGPW
DH22	SECAM-GP Start										(1)	Supply 5V to pin 26.
	Phase 1										(2)	Set bus data as indicated on the left.
DH23	SECAM-GP Start Phase 2	0 45::	×	×	×	0	×	×	×	×	(3)	With the respective bus data settings mentioned above, measure the phase and gate width as shown in the figure below.
DH24	SECAM-GP Gate Width 1	Sub 1FH	×	×	×	1	×	×	×	×		
DH25	SECAM-GP Gate Width 2											SSGP1, 2 SGPW

NOTE	ITEM					(Ui	nless	other	wise s		ed : H	TEST CONDITION I, RGB V _{CC} = 9V; V _{DD} , Fsc V _{DD} , Y / C V _{CC} = 5V; Ta = 25±3°C; BUS = preset value; pin 51 input video signal = 50 system '*x" in the data column represents preset value at power ON.
			S	UB-	-ADD	RES	S & B	US D	ATA	1		MEASURING METHOD
DH27	Noise Detection Level 1 Noise Detection Level 2 Noise Detection Level 3	Sub 1D	C C H)	0 1 0	× ×	× ×	×	x x	×	×	 Input such a signal as shown by "a" of the following figure to pin 51. Set bus data as indicated in the first line of the left table. Measure NLX when amplitude of pin 41 changes. → NL1 Set bus data as indicated in the second line of the left table. Measure NLX when amplitude of pin 41 changes. → NL2 Set bus data as indicated in the third line of the left table. Measure NLX when amplitude of pin 41 changes. → NL3 Set bus data as indicated in the fourth line of the left table. Measure NLX when amplitude of pin 41 changes. → NL4 Measure NLX when amplitude of pin 41 changes. → NL4
DH29	Noise Detection Level 4		1	1	1	×	×	×	×	×	×	Sync 48 2MHz AFC1 filter
DV1	V. Ramp Amplitude	_	_	_	_	_	_	_	_	_	_	(1) Measure amplitude of V. ramp waveform of pin 52.
DV2	V. NF Maximum Amplitude	Sub 17	H 1	1	1	1	1	1	1	1	×	(1) Set data bus as indicated on the left.(2) Measure amplitude of pin 54's signal.
DV3	V. NF Minimum Amplitude	Sub 17	НС)	0	0	0	0	0	0	×	(1) Set data bus as indicated on the left.(2) Measure amplitude of pin 54's signal.

NOTE	ITEM				l					ed : F (Note	
			SUE	3-ADD	RES	S & B	US DA	ATA	1	ı	MEASURING METHOD
DV4	V. Amplification										(1) Set bus data as indicated on the left.
	Degree										(2) Change 5.0V of pin 54 voltage by +0.1V and −0.1V, and measure V ₅₃ output voltage in both the conditions.
											(3) Find GVA shown in the figure below.
											(4) Measure Vvmax and Vvmin shown in the figure below.
DV5	V. Amplifier Max. Output										V ₅₃
		Sub 1BH	1	1	×	×	×	×	×	×	
											Vvmax
	V. Amplifier Min. Output										VvmiN
											v ₅₂
											(1) Adjust the oscilloscope's amplitude with the UNCAL so that pin 52 and pin 54 waveforms overlap each other as the bus data is set to the preset value.
											(2) Change the bus data as indicated on the left, and measure values of X and Y shown in the figure below.
											(3) Find V _S according to the equation that V _S = (X / Y)×100%.
DV7	V. S-Curve Correction, Max. Correction Quantity	Sub 19H	1	1	1	1	1	1	1	×	Pin 52 ramp output Y X V. HF output

NOTE	ITEM		SUB	-ADD	Ĺ						TEST CONDITION I, RGB V _{CC} = 9V; V _{DD} , Fsc V _{DD} , Y / C V _{CC} = 5V; Ta = 25±3°C; BUS = preset value; pin 51 input video signal = 50 system "×" in the data column represents preset value at power ON. MEASURING METHOD
DV8	V. Reverse S-Curve Correction, Max. Correction Quantity	Sub 19H	0	0	0	0	0	0	0	×	 (1) Adjust the oscilloscope's amplitude with the UNCAL so that pin 52 and pin 54 waveforms overlap each other as the bus data is set to the preset value. (2) Change the bus data as indicated on the left, and measure values of X and Y shown in the figure below. (3) Find V_S according to the equation that V_S = (X / Y)×100%.
DV9	V. Linearity Max. Correction Quantity	Sub 1AH	1	1	1	1	1	×	×	×	 (1) Adjust the oscilloscope's amplitude with the UNCAL so that pin 52 and pin 54 waveforms overlap each other as the bus data is set to the preset value. (2) Change the bus data as indicated on the left, and measure values of X and Y shown in the figure below. (3) Find V_S according to the equation that V_S = (X / 2Y)×100%.

NOTE	ITEM		SUE	3-ADD	l					ed : H (Note	TEST CONDITION I, RGB V _{CC} = 9V; V _{DD} , Fsc V _{DD} , Y / C V _{CC} = 5V; Ta = 25±3°C; BUS = preset value; pin 51 input video signal = 50 system "*" in the data column represents preset value at power ON. MEASURING METHOD
DV10	AFC-MASK Start Phase		301		NEO.	3 & Di	00 D				(1) Supply 5V DC to pin 26. (2) Set bus data as indicated on the left and activate the test mode. (3) Measure the AFC-MASK start phase (X) and AFC-MASK stop phase (Y) of pin 49. (4) Set the Sub 16H as indicated on the left.
DV11	AFC-MASK Stop Phase	Sub 02H	0	0	0	0	0	0	0	1	(5) Measure the VNFB start phase (Z) of pin 54.
DV12	VNFB Phase	Sub 16H	×	×	×	×	×	0	0	0	(49) X Y S
DV13	V. Output Maximum Phase										 Input video signal to pin 51. Measure both phases (Xmax, Xmin) of pin 52 and pin 54 with the respective bus data settings shown on the left. Find difference between the two phases measured in the above step 2.
DV14	V. Output Minimum Phase	Sub 16H	×	×	×	×	×	0	0	0	Y = Xmax - Xmin (52) Xmax
DV15	V. Output Phase Variable Range										Xmin Xmin



NOTE	ITEM		SUE	3-ADD	Ĺ						TEST CONDITION I, RGB V _{CC} = 9V; V _{DD} , Fsc V _{DD} , Y / C V _{CC} = 5V; Ta = 25±3°C; BUS = preset value; pin 51 input video signal = 50 system "*" in the data column represents preset value at power ON. MEASURING METHOD
DV21	V. Lead-In Range 2	Sub 16H		×	×	0	1	0	0	0	 Set bus data as indicated on the left. Input 262.5 H video signal to pin 51. Set a certain number of field lines in which signals of pin 51 and pin 54 completely synchronize with each other as shown in the figure below. Decrease the field lines in number and measure number of lines in which pin 51 and pin 54 signals do not synchronize with each other. Again set a certain number of field lines in which pin 51 and pin 52 signals synchronize with each other. Increase the field lines in number and measure number of lines in which pin 51 and pin 52 signals do not synchronize with each other.
DV22	W-VBLK Start Phase	Sub 1BH	×	×	0	0	0	0	0	0	(1) Set bus data as specified for the Sub 1BH in the left columns, and measure the value of X shown in the figure below. W-VBLK start phase: MAX, MIN (2) Set bus data as specified for the Sub 1DH in the left columns, and measure the value of X shown in the figure below.
DV23	W-PMUTE Start Phase (Note) Only the 60 system is subject to evaluation.	Sub 1DH	×	×	0	0	0 1	0 1	0	0	W-PMUTE start phase : MAX, MIN

NOTE	ITEM					Ĺ					ed : H (Note)	
				SUE	B-ADE	RES	S & B	US D	ATA			MEASURING METHOD
DV24	W-VBLK Stop Phase			×	0	0	0	0	0	0	0	(1) Set bus data as specified for the Sub 1CH in the left columns, and measure the value of Y shown in the figure below. W-VBLK stop phase : MAX, MIN
DV25	W-PMUTE Stop	Sub	1CH	×	1	1	1	1	1	1	1	(2) Set bus data as specified for the Sub 1EH in the left columns, and measure the value of Y shown in the figure below. W-PMUTE stop phase: MAX, MIN
	Phase (Note) Only the 60	Sub	1EH	×	0	0	0	0	0	0	0	52)
	system is subject to evaluation.			×	1	1	1	1	1	1	1	①
DV26	V Centering Center											(1) Set bus data as indicated on the left.
	Voltage			1	0	0	0	0	0	×	×	(2) Measure the voltage of pin 47 with respective bus data settings.
DV27	V Centering Max Voltage	Sub	18H	1	1	1	1	1	1	×	×	
DV28	V Centering Min Voltage			0	0	0	0	0	0	×	×	

1H DL SECTION

			TEST	CONDIT	TON (U	lless otherwise specified : H, RGB V _{CC} = 9V ; V _{DD} , Fsc V _{DD} , Y / C V _{CC} = 5V ; Ta = 25±3°C ; BUS = preset value ; pin3 = 9V ; pin8 · 38 · 41 = 5V)
NOTE	ITEM	SW MODE	SUB	ADDRE DATA		MEASURING METHOD
		S26	07H	0FH	11H	
						(1) Input waveform 1 to pin 33 (B · Yin) , and measure VNBD, that pin 36 (B · Yout) is saturated input level.
H ₁	1HDL Dynamic Range Direct	ON	94H	_	_	(2) Measure VNRD of R · Y input in the same way as VNBD. Wavefor 10.7V (typ)
						H.BLK
ш	1HDL Dynamic	•	8CH			(1) Input waveform 1 to pin 33 (B-Yin), and measure VPBD, that pin 36 (B-Yout) is saturated input level.
H ₂	Range Delay	1	оСП	_		(2) Measure VPRD of R-Y input in the same way as VPBD.
	1HDL Dynamic					(1) Input waveform 1 to pin 33 (B-Yin), and measure VSBD, that pin 36 (B-Yout) is saturated input level.
	Range, Direct+Delay	1	A4H	_	_	(2) Measure VNRD of R-Y input in the same way as VSBD.
	Frequency					(1) In the same measuring as H ₁ , set waveform 1 to 0.3V _{p-p} and f = 100kHz. Measure VB100, that is pin 36 (B-Yout) level. And set waveform 1 to f = 700kHz. Measure VB700, that is pin 36 (B-Yout) level.
H ₄	Characteristic, Direct	↑	94H	_	_	GHB1 = 20log (VB700 / VB100)
	Billoot					(2) Measure GHR1 of R-Y out in the same way as GHB1.
	Frequency					(1) In the same measuring as H ₁ , set waveform 1 to 0.3V _{p-p} and f = 100kHz. Measure VB100, that is pin 36 (B-Yout) level. And set waveform 1 to f = 700kHz. Measure VB700, that is pin 36 (B-Yout) level.
H ₅	Characteristic, Delay	1	8CH	_	_	GHB2 = 20log (VB700 / VB100)
						(2) Measure GHR2 of R-Y out in the same way as GHB2.Measure VB700, that is pin 36 (B-Yout) level.
						(1) In the same measuring as H ₁ , set waveform 1 to 0.7V _{p-p} . Measure VByt1, that is pin 36 (B-Yout) level.
H ₆	AC Gain Direct	1	94H	_	_	GBY ₁ = 20log (VByt1 / 0.7)
						(2) Measure GRY1 of R-Y out in the same way as GBY1.
						(1) In the same measuring as H_1 , set waveform 1 to $0.7V_{p-p}$. Measure VByt2, that is pin 36 (B-Yout) level.
H ₇	AC Gain Delay	↑	8CH	_	_	$GBY_2 = 20log (VByt2 / 0.7)$
						(2) Measure GRY2 of R-Y out in the same way as GBY2.

			TEST	CONDIT	ΓΙΟΝ (U	nless otherwise specified : H, RGB V _{CC} = 9V ; V _{DD} , Fsc V _{DD} , Y / C V _{CC} = 5V ; Ta = 25±3°C ; BUS = preset value ; pin3 = 9V ; pin8 · 38 · 41 = 5V)
NOTE	ITEM	SW MODE	SUB	ADDRE DATA	SS &	MEASURING METHOD
		S26	07H	0FH	11H	
H ₈	Direct · Delay AC Gain Difference	ON	94H 8CH	_	_	(1) GBYD = GBY1 - GBY2(2) GRYD = GRY1 - GRY2
H ₉	Color Difference Output DC Stepping	1	8CH	_	_	(1) Measure pin 36 (B-Yout) DC stepping of the picture period.(2) Measure pin 35 (R-Yout) DC stepping of the picture period.
H ₁₀	1H Delay Quantity	1	8CH	_	_	(1) Input waveform 2 to pin 33 (B-Yin). And measure the time deference BDt of pin 36 (B-Yout). (2) Input waveform 2 to pin 34 (R-Yin). And measure the time difference RDt of pin 36 (B-Yout). Output waveform H.BLK
H ₁₁	Color Difference Output DC-Offset Control	1	8CH	20H	00H 88H FFH	 Set Sub-Address 11h; data 88h. Measure the pin 36 DC voltage, that is BDC1. Set Sub-Address 11h; data 88h. Measure the pin 35 DC voltage, that is RDC1. Set Sub-Address 11h; data 00h. Measure the pin 36 DC voltage, that is BDC2. Set Sub-Address 11h; data 00h. Measure the pin 35 DC voltage, that is RDC2. Set Sub-Address 11h; data FFh. Measure the pin 36 DC voltage, that is BDC3. Set Sub-Address 11h; data FFh. Measure the pin 35 DC voltage, that is RDC3. Set Sub-Address 11h; data FFh. Measure the pin 35 DC voltage, that is RDC3. Bomin = BDC2 - BDC1, Bomax = BDC3 - BDC1, Romin = RDC2 - RDC1, Romax = RDC3 - RDC1
H ₁₂	Color Difference Output DC-Offset Control / Min. Control Quantity	1	A4H	00H	89H	 (1) Measure the pin 36 DC voltage, that is BDC4. (2) Measure the pin 35 DC voltage, that is RDC4. (3) Bo1 = BDC4 - BDC1, Ro1 = RDC4 - RDC1
H ₁₃	NTSC Mode Gain / NTSC-COM Gain	1	94H	80H	_	 (1) Input waveform 1, that is set 0.3V_{p-p} and f = 100kHz, to pin 33. Measure pin 36 output level, that is VBNC. (2) GNB = 20log (VBNC / VB100) (3) In the same way as (1) and (2), measure the pin 36 output level, that is VRNC. GNR = 20log (VRNC / VR100)

TEXT SECTION

				TE				Jnless	otherv	vise sp	ecified	: H, R	GB V _C	CC = 9\	√; V _D	, Fsc	V _{DD} , Y / C V _{CC} = 5V ; Ta = 25±3°C ; BUS = preset value)
NOTE	ITEM	S ₂₁	S ₂₂	S ₃₁	_	W MOI		Ι_	Ι	I		JB-AD 02H		S & BI	JS DA	TA I —	MEASURING METHOD
T ₁	Y Color Difference Clamping Voltage	В	В	В	В	В	А	_	_	_	FFH		_	_	_	_	 Short circuit pin 31 (Y IN), pin 34 (R-Y IN) and pin 33 (B-Y IN) in AC coupling. Input 0.3V synchronizing signal to pin 51 (Sync IN). Measure voltage at pin 31, pin 34 and pin 33 (Vcp31, Vcp34, Vcp33).
T ₂	Contrast Control Characteristic	1	1	↑	Î	1	1	_	_	_	FFH 80H 00H	00Н	_	_	_	_	 (1) Input TG7 sine wave signal whose frequency is 100kHz and video amplitude is 0.7V to pin 31 (Y IN). (2) Input 0.3V Synchronizing Signal to pin 51 (Sync IN). (3) Connect both pin 21 (Digital Ys) and pin 22 (Analog Ys) to ground. (4) Set bus data so that Y sub contrast and drive are set at each center value and color is minimum. (5) Varying data on contrast from maximum (FF) to minimum (00), measure maximum and minimum amplitudes of respective outputs of pin 14 (R OUT), pin 13 (G OUT) and pin 12 (B OUT) in video period, and read values of bus data at the same time. Also, measure the respective amplitudes with the bus data set to the center value (80). (Vc12mx, Vc12mn, D12c80) (Vc13mx, Vc13mn, D13c80) (Vc14mx, Vc14mn, D14c80) (6) Find ratio between amplitude with maximum unicolor and that with minimum unicolor in conversion into decibel (ΔV13ct).
Т3	AC Gain	1	1	1	1	1	1	_	_	_	_	_	_	_	_	_	In the test condition of Note T ₂ , find output / input gain (double) with maximum contrast. G = Vc13mx / 0.7V

				TE	ST C	TIDNC	ION (L	Jnless	otherv	ise sp	ecified	l : H, F	RGB V _C	C = 9\	/ ; V _{DI}	o, Fsc	V_{DD} , Y / C V_{CC} = 5V ; Ta = 25±3°C ; BUS = preset value)
NOTE	ITEM				S۱	N MOI	DE				SI	UB-AD	DRES	S & Bl	JS DA	TA	MEASURING METHOD
		S ₂₁	S ₂₂	S ₃₁	S_{33}	S ₃₄	S ₅₁	_	_	_	00H	02H	_	_	_	_	MEXIODITING METITIOS
																	(1) Input TG7 sine wave signal whose frequency is 6MHz and video amplitude is 0.7V to pin 31 (Y IN).
																	(2) Input 0.3V synchronizing signal to pin 51 (Sync IN).
																	(3) Connect both pin 21 (Digital Ys) and pin 22 (Analog Ys) to ground.
T ₄	Frequency Characteristic	В	В	В	В	В	А	_	_	_	FFH	00H	_	_	_	_	(4) Set bus data so that contrast is maximum, Y sub contrast and drive are set at each center value and color is minimum.
																	(5) Measure amplitude of pin 13 signal (G OUT) and find the output / input gain (double) (G6M).
																	(6) From the results of the above step 5 and the Note T ₃ , find the frequency characteristic.
																	Gf = 20log (G6M / G)

				TE				Inless	otherw	ise sp							V_{DD}	, Y / C V _{CC} = 5V ; Ta = 25±3°C ; BUS = preset value)
NOTE	ITEM					N MOI									JS DA	ΓA		MEASURING METHOD
		S ₂₁	S ₂₂	S ₃₁	S_{33}	S ₃₄	S ₅₁	S ₄₂	_	_	00H	02H	05H	1BH	H80	_		
																	(1)	Connect both pin 21 (Digital Ys) and pin 22 (Analog Ys) to ground.
																	(2)	Input TG7 sine wave signal whose frequency is 100kHz and video amplitude is 0.7V to pin 31 (Y IN).
																	(3)	Input 0.3V synchronizing signal to pin 51 (Sync IN).
T ₅	Y Sub-Contrast Control Characteristic	В	В	В	В	В	Α	_	_	_	FFH	00H	1FH 00H	_	_	_	(4)	Set bus data so that contrast is maximum, drive is set at center value and color is minimum.
																	(5)	Set bus data on Y sub contrast at maximum (FF) and measure amplitude (Vscmx) of pin 14 output (R OUT). Then, set data on Y sub contrast at minimum (00), measure the same (Vscmn).
																	(6)	From the results of the above step 5, find ratio between Vscmx and Vscmn in conversion into decibel (Δ Vscnt).
																	(1)	Set bus data so that contrast is maximum, Y sub contrast and drive are at each center value.
Т6	Y ₂ Input Level	1	1	1	↑	↑	↑	_	_	_	1	_	_	BFH	44H	_	(2)	Input 0.3V synchronizing signal to pin 51 while inputting TG7 sine wave signal whose frequency is 100kHz to pin 31 (TY IN).
																	(3)	While increasing the amplitude of the sine wave signal, measure video amplitude of signal 1 just before R output of pin 14 is distorted. (Vy2d)

				TE				Jnless	otherv	vise sp							V _{DD} , Y / C V _{CC} = 5V ; Ta = 25±3°C ; BUS = preset value)
NOTE	ITEM					N WOI			1	T				S & BI			MEASURING METHOD
T ₇	Unicolor Control Characteristic	B	S ₂₂	S ₃₁	В	В	S ₅₁	S ₄₂	_	_	FFH 80H 00H		_	BFH		_	 Input 0.3V synchronizing signal to pin 51 (Sync IN). Input 100kHz, 0.3V_{p-p} sine wave signal to both pin 33 (B-Y IN) and pin 34 (R-Y IN). Connect pin 21 (Digital Ys) and pin 22 (Analog Ys) to ground. Set bus data so that drive is at center value and Y mute is on. While changing bus data on unicolor from maximum (FF) to minimum (00), measure maximum and minimum amplitudes of pin 13 (G OUT) and pin 12 (B OUT) in video period respectively, and read the bus data together with. Also, measure respective amplitudes as unicolor data is set at center value (80). (Vn12mx, Vn12mn, D12n80) (Vn13mx, Vn13mn, D13n80) (Vn14mx, Vn14mn, D14n80) Find ratio between amplitude with maximum unicolor data and that with minimum unicolor data in conversion into decibel (ΔV13un).
Т8	Relative Amplitude (NTSC)	1	1	А	А	А	1	А	_	_	FFH	_	_	1	_	_	While inputting rainbow color bar signal (3.58MHz for NTSC) to pin 42 and 0.3V synchronizing signal to pin 51 so that video amplitude of pin 33 is 0.38V _{p-p} , find the relative amplitude (Mnr-b = Vu14mx / Vu12mx, Mng-b = Vu13mx / Vu12mx).
T ₉	Relative Phase (NTSC)	1	1	1	1	1	1	1	_	_	1	_	_	1	_	_	 In the test condition of the Note T₈, adjust bus data on tint so that output of pin 12 (B OUT) has the peak level in the 6th bar. Regarding the phase of pin 12 (B OUT) as a reference phase, find comparative phase differences of pin 14 (R OUT) and pin 13 (G OUT) from the reference phase respectively (θnr-b, θng-b).

				TE				Jnless	otherw	ise sp	ecified	l : H, R	GB V _C	CC = 9\	√ ; V _{D[}	, Fsc	V _{DD} , Y / C V _{CC} = 5V ; Ta = 25±3°C ; BUS = preset value)
NOTE	ITEM	C	S ₂₂	S ₃₁		W MOI		S ₄₂					DRES 1BH	S & Bl	JS DA	TA	MEASURING METHOD
T ₁₀	Relative Amplitude (PAL)	В	В	A	A	A	A	A	_	_	FFH		ВЕН	_	_	_	While inputting rainbow color bar signal (4.43MHz for PAL) to pin 42 and 0.3V synchronizing signal to pin 51 so that video amplitude of pin 33 is 0.38V _{p-p} , find the relative amplitude. (Mpr-b = Vu14mx / Vu12mx, Mpg-b = Vu13mx / Vu12mx)
T ₁₁	Relative Phase (PAL)	1	1	1	1	1	1	1	_	_	1	_	_	_	_	_	 In the test condition of the Note T₁₀, adjust bus data on tint so that output of pin 12 (B OUT) has the peak level in the 6th bar. Regarding the phase of pin 12 (B OUT) as a reference phase, find comparative phase differences of pin 14 (R OUT) and pin 13 (G OUT) from the reference phase respectively (θpr-b, θpg-b).
T ₁₂	Color Control Characteristic	1	1	В	В	В	î	_	_	_	1	FFH	1	_	_	_	 Input 0.3V synchronizing signal to pin 51 (Sync IN). Input 100kHz, 0.1V_{p-p} sine wave signal to both pin 33 (B-Y IN) and pin 34 (R-Y IN). Connect pin 21 (Digital Ys) and pin 22 (Analog Ys) to ground. Set bus data so that unicolor is maximum, drive is at center value and Y mute is on. Measure amplitude of pin 12 (B OUT) as bus data on color is set maximum (FF). (Vcmx) Read bus data when output level of pin 12 is 10%, 50% and 90% of Vcmx respectively (Dc10, Dc50, Dc90).
T ₁₃	Color Control Characteristic, Residual Color	1	1	1	1	1	1	_	_	_	1	00Н	1	_	_	_	(7) From results of the above step 6, calculate number of steps from Dc10 to Dc90 (\(\Delta\text{col}\)) and that from 00 to Dc50 (ecol). (8) Measure respective amplitudes of pin 12 (B OUT), pin 13 (G OUT) and pin 14 (R OUT) with color data set at minimum, and regard the results as color residuals (ecb, ecg, ecr).

				TE	EST CO	TIDNC	ION (L	Jnless	otherv	vise sp	ecified	: H, F	RGB V _C	CC = 9\	/ ; V _D	_D , Fsc	V _{DD} , Y / C V _{CC} = 5V ; Ta = 25±3°C ; BUS = preset value)
NOTE	ITEM				S۱	N MOI	DE				S	UB-AD	DRES	S & Bl	JS DA	TA	MEASURING METHOD
		S ₂₁	S ₂₂	S ₃₁	S ₃₃	S ₃₄	S ₅₁	S ₄₂	_	_	00H	02H	1BH	_	_	_	WEAGONING WE ITIOD
																	(1) Input rainbow color bar signal (3.58MHz for NTSC or 4.43MHz for PAL) to pin 42 (C IN) and 0.3V synchronizing signal to pin 51 (Sync IN).
																	(2) Connect pin 36 (B-Y OUT) and pin 33 (B-Y IN), pin 35 (R-Y OUT) and pin 34 (R-Y IN) in AC coupling respectively.
T ₁₄	Chroma Input Range	В	В	Α	Α	Α	Α	Α	_	_	FFH	88H	BFH	_	_	_	(3) Connect pin 21 (Digital Ys) and pin 22 (Analog Ys) to ground.
																	(4) Set bus data so that unicolor is maximum, drive and color are set at each center value (80) and mute is on.
																	(5) While increasing amplitude of chroma signal input to pin 42, measure amplitude just before any of pin 12 (B OUT), pin 13 (G OUT) and pin 14 (R OUT) output signals is distorted (Vcr).

				TE				Inless	otherw	ise sp							V _{DD} , Y / C V _{CC} = 5V ; Ta = 25±3°C ; BUS = preset value)
NOTE	ITEM	S ₂₁	S ₂₂	S ₃₁		N MOI	DE S ₅₁	_	l	T		JB-AD 05H		S & BU	JS DA	TA	MEASURING METHOD
T ₁₅	Brightness Control Characteristic	В	В	В	В	В	A	_	_	_	FFH 00H	10H	_	_	_	_	 Short circuit pin 31 (Y IN), pin 33 (B-Y IN) and pin 34 (R-Y IN) in AC coupling. Input 0.3V synchronizing signal to pin 51 (Sync IN). Set bus data so that R, G, B cut off data are set at center value.
T ₁₆	Brightness Center Voltage	1	1	1	1	1	1	_	_	_	80H	1	_	_	_	_	 (4) Connect pin 21 (Digital Ys) and pin 22 (Analog Ys) to ground. (5) While changing bus data on brightness from maximum to minimum, measure video voltage of pin 13 (G OUT) to find maximum and minimum voltages (max: Vbrmx, min: Vbrmn). (6) With bus data on brightness set at center value, measure video voltage of pin 13 (G OUT) (Vbcnt).
T ₁₇	Brightness Data Sensitivity	1	1	1	1	1	1	_	_	_	-	_	_	_	_	_	 (7) On the conditon that bus data with which Vbrmx is obtained in measurement of the above step 5 is Dbrmx and bus data with which Vbrmn is obtained in measurement of the above step 5 is Dbrmn, calculate sensitivity of brightness data (ΔVbrt). ΔVbrt = (Vbrmxg - Vbrmng) / (Dbrmxg - Dbrmng)
T ₁₈	RGB Output Voltage Axes Difference	1	1	1	1	1	1	_	_	_	_	_	_	_	_	_	 (1) In the same manner as the Note T₁₆, measure video voltage of pin 12 (B OUT) with bus data on brightness set at center value. (2) Find maximum axes difference in the brightness center voltage.
T ₁₉	White Peak Limit Level	1	1	1	1	1	1	_	_	_	00H	1FH	_	_	_	_	 Set bus data so that contrast and Y sub contrast are maximum and brightness is minimum. Input TG7 sine wave signal whose frequency is 100kHz and amplitude in video period is 0.9V to pin 31 (Y IN). Connect pin 21 (Digital Ys) and pin 22 (Analog Ys) to ground. While turning on / off WPL with bus, measure video amplitude of pin 14 (R OUT) with WPL being activated (Vwpl).

				TE	ST C	DNDIT	ION (L	Inless	otherw	ise sp							V_{DD}	, Y / C V _{CC} = 5V ; Ta = 25±3°C ; BUS = preset value)
NOTE	ITEM	_	<u> </u>	_		N MOI		1	1	1					JS DA			MEASURING METHOD
	0.1.50	S ₂₁	S ₂₂	S ₃₁	533	S ₃₄	S ₅₁	_		_	09H	UAH		FFH	0EH FFH		(1)	Short circuit pin 31 (Y IN), pin 33 (B-Y IN) and pin 34 (R-Y IN) in AC coupling.
T ₂₀	Cutoff Control Characteristic	В	В	В	В	В	A		_	_	80H	80H	00H	00H	00H	_	(2) (3)	
																	(4)	Set bus data on brightness at center value.
T ₂₁	Cutoff Center Level	1	1	1	↑	1	1	_	_	_	↑	1	80H	80H	80H	_	(5)	While changing data on cutoff from maximum to minimum, measure video voltage of pin 13 (G OUT) to find maximum and minimum values (max : Vcomx, min : Vcomn).
																	(6)	Set cutoff data at center value and measure video voltage of pin 13 (G OUT) (Vcoct).
T ₂₂	Cutoff Variable Range	↑	1	↑	↑	↑	1	_	_	_	-		_	_	_	_	(7)	On the condition that bus data with which Vcomx is obtained in measurement of the above step 5 is Dcomx and bus data with which Vcomn is obtained in the same is Dcomn, calculate number of steps (Δ Dcut).
																		ΔDcut = Dcomx - Dcomn
																	(1)	Short circuit pin 33 (B-Y IN) and pin 34 (R-Y IN) in AC coupling.
																	(2)	Input a stepping signal whose amplitude in video period is 0.3V to pin 31 (Y IN).
																	(3)	Input 0.3V synchronizing signal to pin 51 (Sync IN).
																	(4)	Connect pin 21 (Digital Ys) and pin 22 (Analog Ys) to ground.
T ₂₃	Drive Variable Range	1	1	1	↑	1	1	_	_	_	FFH 00H		80H	80H	80H	_	(5)	Set bus data so that contrast is maximum and Y sub contrast is minimum.
											0011	0011					(6)	While changing drive data from minimum to maximum, measure video amplitude of pin 13 (G OUT) to find maximum and minimum values (max: Vdrmx, min: Vdrmn).
																	(7)	Set drive data at center value and measure video amplitude of pin 13 (G OUT) (Vdrct). Calculate amplitude ratio of the measured value to the maximum and minimum amplitudes measured in the above step 6 respectively (DR+, DR-).

				TE	EST CO	TIDNC	ION (L	Jnless	otherw	ise sp							V _{DD} , Y / C V _{CC} = 5V ; Ta = 25±3°C ; BUS = preset value)
NOTE	ITEM	_	_	_		N MOI		_			SI	JB-AD	DRES	S & BI	JS DA	TA	MEASURING METHOD
		S ₂₁	S ₂₂	S ₃₁	S_{33}	S ₃₄	S ₅₁	S ₄₅	S ₃₉	S ₄₄	_	_	_	_	_	_	
																	(1) Short circuit pin 33 (B-Y IN) and pin 34 (R-Y IN) in AC coupling.
																	(2) Input such the step-up signal as shown below to pin 45 (Y IN) and pin 51 (Sync IN).
																	(3) Connect pin 21 (Digital Ys) and pin 22 (Analog Ys) to ground.
																	(4) Set bus data so that contrast is maximum and DC transmission correction factor is minimum.
T ₂₄	DC Regeneration	В	В	А	В	В	Α	В	Α	Α	_	_	_	_	_	_	(5) Adjust data on Y sub contrast so that video amplitude of pin 13 (G OUT) is 2.5V.
																	(6) While varying APL of the step-up signal from 10% to 90%, measure change in voltage at the point A.
																	100 Variable APL Point A.
																	(1) Short circuit pin 31 (Y IN), pin 33 (B-Y IN) and pin 34 (R-Y IN) in AC coupling.
																	(2) Input synchronizing signal of 0.3V in amplitude to pin 51 (Sync IN).
																	(3) Connect pin 21 (Digital Ys) and pin 22 (Analog Ys) to ground.
T ₂₅	RGB Output S / N Ratio	↑	↑	В	↑	↑	↑	_	_	_	_	_	_	_	_	—	(4) Set bus data on contrast at maximum.
																	(5) Set bus data on Y sub contrast at center value.
																	(6) Measure video noise level of pin 13 (G OUT) with oscilloscope (no).
																	SNo = −20ℓog (2.5 / (1 / 5) ×no)

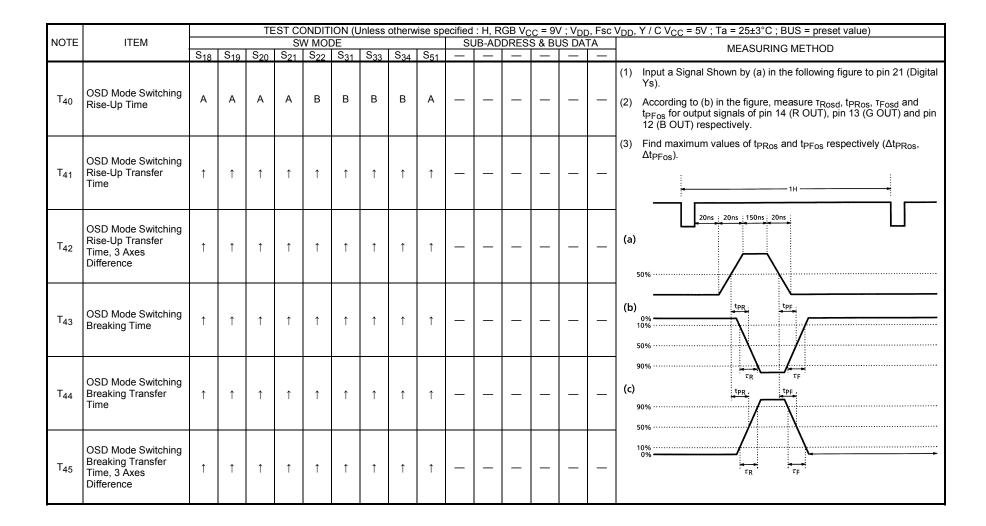
TB1227CNG

				TE	ST C	DNDIT	ION (L	Jnless	otherw	ise sp	ecified	: H, R	GB V _C	CC = 9)	V ; V _{DI}	D, Fsc	V_{DD} , Y / C V_{CC} = 5V ; Ta = 25±3°C ; BUS = preset value)
NOTE	ITEM	•				N WOI		1	1	1					US DA		MEASURING METHOD
		S ₂₁	S ₂₂	S ₃₁	533	S ₃₄	S ₅₁	_	_	_	UTH	USH	U8H	UCH	0DH	UEH	
																	(1) Input synchronizing signal of 0.3V in amplitude to pin 51 (Sync IN)
	District Duty Contact																(2) Connect pin 21 (Digital Ys) and pin 22 (Analog Ys) to ground.
T ₂₆	Blanking Pulse Output Level	В	В	В	В	В	Α	_	_	_	80H	10H	04H	80H	80H	80H	(3) Set bus data so that blanking is on.
																	(4) Measure voltage of pin 13 (G OUT) in V. blanking period (Vv).
																	(5) Measure voltage of pin 13 (G OUT) in H. blanking period (Vh).
																	In the setting condition of the Note T_{26} , find " t_{don} " and " t_{doff} " (see figure below) between the signal impressed to pin 6 (BFP IN) and output signal of pin 13 (G OUT).
T ₂₇	Blanking Pulse Delay Time	↑	1	1	↑	1	1	_	_	_	↑	1	1	1	1	↑	Signal impressed to pin 6
																	Pin 13 output signal
																	(1) Short circuit pin 31 (Y IN), pin 33 (B-Y IN) and pin 34 (R-Y IN) in AC coupling.
1_	RGB Min. Output																(2) Input synchronizing signal of 0.3V in amplitude to pin 51 (Sync IN).
T ₂₈	Level	1	1	1	1	1	1	_	_	_	00H	1	1	00H	00H	00H	(3) Connect pin 21 (Digital Ys) and pin 22 (Analog Ys) to ground.
																	(4) Set bus data so that brightness and RGB cutoff are minimum.
																	(5) Measure video voltage of pin 13 (G OUT) (Vmn).
																	(1) Short circuit pin 33 (B-Y IN) and pin 34 (R-Y IN) in AC coupling.
																	(2) Input stepping signal to pin 31 (Y IN) and synchronizing signal of 0.3V in amplitude to pin 51 (Sync IN).
	RGB Max. Output											4611			2211		(3) Connect pin 21 (Digital Ys) and pin 22 (Analog Ys) to ground.
T ₂₉	Level	↑	1	1	1	1	1	_	_	_	80H	1fH	44H	80H	80H	80H	(4) Set bus data so that contrast and Y sub contrast are maximum.
																	(5) While increasing amplitude of the stepping signal, measure maximum output level just before video signal of pin 13 (G OUT) is distorted (Vmn).

				TE				Jnless	otherw	ise sp							V _{DD} ,	Y / C V _{CC} = 5V ; Ta = 25±3°C ; BUS = preset value)
NOTE	ITEM	S10	S10	San		W MOI		S ₃₃	S24	S ₅₁				S & BU	JS DA	TA 	_	MEASURING METHOD
		018	0 19	320	521	322	331	333	034	231	1011						(1)	Input stepping signal whose amplitude is 0.3V in video period to pin 31 (Y IN) and pin 51 (Sync IN).
T ₃₀	Halftone Ys Level	В	В	В	Α	В	В	В	В	А	00H	80H	_	_	_	_	(2)	Set bus data so that blanking is off and halftone is −3dB in on status.
																	(3)	Connect power supply to pin 21 (Digital Ys). While impressing 0V to it, measure amplitude and pedestal level of pin 13 (G OUT) in video period (Vm13, Vp13).
T ₃₁	Halftone Gain 1	1	1	1	1	1	1	1	1	1	1	1	_	_	_	_	(4)	Raising supply voltage to pin 21 gradually from 0V, measure level (Vtht1) of pin 21 when amplitude of pin 13 output signal changes. At the same time, measure amplitude and pedestal level of pin 13 in video period after the pin 13 output signal changed in amplitude. (Vm13b, Vp13b)
																	(5)	According to results of the above steps 3 and 4, calculate gain of –3dB halftone and variation of pedestal level.
T ₃₂	Halftone Gain 2	1	1	1	1	1	1	1	1	1	01H	1	—	_	_	—		G3ht13 = 20 ℓog (Vm13b / Vm13)
																	(6)	Set bus data so that halftone is -6dB in on status, and perform the same measurement as the above steps 4 and 5 to find gain of -6dB halftone and variation of pedestal level (G6th13).
T ₃₃	Text ON Ys, Low Level	1	1	1	1	1	1	1	1	1	1	1	_	_	_	_	(7)	Raising supply voltage to pin 21 further from Vtht1, measure level (Vttx1) of pin 21 when output signal of pin 13 (G OUT) changes in amplitude and DC level of pin 13 after the change of its output (Vtx13).
																	(8)	From results of the above steps 3 and 7, calculate low level of the output in the text mode.
T ₃₄	Text / OSD Output, Low Level	 	1	 	 	 	1	1	 	 	↑	1	_	_	_	_	(9)	Vtxl13 = Vtx13 - Vp13 Raising supply voltage to pin 21 by 3V from that in the above step
	Low Level							·		·								7, confirm that there is no change in output level of pin 13.

				TE	EST CO	DNDIT	ION (U	Inless	otherw	ise sp							V _{DD} , `	Y / C V _{CC} = 5V ; Ta = 25±3°C ; BUS = preset value)
NOTE	ITEM					N WOI			· ·	1		JB-AD 1CH	DRES:	S & Bl	JS DA	TA		MEASURING METHOD
		318	319	320	321	322	S ₃₁	S ₃₃	351		1511	ICH						Input stepping signal whose amplitude is 0.3V in video period to pin 31 (Y IN) and pin 51 (Sync IN).
T ₃₅	Text RGB Output, High Level	Α	А	А	А	В	В	В	А	_	02H	80H	_	_	_	_	(3)	Set bus data so that blanking and halftone are off. Connect power supply to pin 21 (Digital Ys). While impressing 0V to it, measure pedestal level of pin 13 output signal (G OUT) (Vpl13).
																		Connect power supply to pin 19 (Digital G IN) and impress it with 2V.
																		Raising supply voltage to pin 21 gradually from 0V, measure video level of pin 21 after output signal of pin 13 changed (Vlx13).
T ₃₆	OSD Ys ON, Low Level	1	1	1	1	1	↑	1	1	_	1	1	_	_	_	_		From measurement results of the above steps 3 and 5, calculate high level in the text mode.
																		Vmt13 = Vtx13 - Vpt13
																	- `´	Raising supply voltage to pin 21 further from that in the step 5, measure level (Vtost) of pin 21 when the level of pin 13 output
																		signal changes from that in the step 5 to $-6dB$ as halftone data is set to ON (the 6th step of Notes T_{30} to T_{34}).
T ₃₇	OSD RGB Output,	1	1	↑	1 ↑	1	↑	↑	 	_	1	1	_	_	_	_		In the condition of the above step 7, raise voltage impressed to pin 19 to 3V and measure output voltage of pin 13 (Vos13).
	High Level							•										From results of the above steps 3 and 7, calculate high level of the output in the OSD mode.
																		Vmos13 = Vos13 - Vpt13

				TE	ST C	TIDNC	ION (L	Jnless	otherw	ise sp	ecified	: H, R	GB V _C	C = 9\	/ ; V _{DE}	, Fsc	V _{DD} ,	Y / C V _{CC} = 5V ; Ta = 25±3°C ; BUS = preset value)
NOTE	ITEM					w Moi					Sl	JB-AD	DRES	S & Bl	JS DA	TA		MEASURING METHOD
		S ₁₈	S ₁₉	S ₂₀	S ₂₁	S ₂₂	S ₃₁	S ₃₃	S ₃₄	S ₅₁	_	_	_	_	_	_		MEAGONING METHOD
																	(1)	Connect power supply to pin 21 (Digital Ys) and impress 1.5V to it.
T ₃₈	Text Input Threshold Level	Α	А	А	Α	В	В	В	В	Α	_	_	_	_	_	_	(2)	Connect power supply to pin 19 (Digital G IN). While raising supply voltage gradually from 0V, measure supply voltage when output signal of pin 13 (G OUT) changes (Vtxt).
																	(3)	Raising the supply voltage to pin 19 furthermore to 4V, confirm that there is no change in the output signal of pin 13 (G OUT).
																	(1)	Connect power supply to pin 21 (Digital Ys) and impress 2.5V to it.
T ₃₉	OSD Input Threshold Level	1	1	↑	1	1	1	1	1	1	_	_	_	_	_	_	(2)	Connect power supply to pin 19 (Digital G IN). While raising supply voltage gradually from 0V, measure supply voltage when output signal of pin 13 (G OUT) changes (Vosd).
																	(3)	Raising the supply voltage to pin 19 furthermore to 4V, confirm that there is no change in the output signal of pin 13 (G OUT).



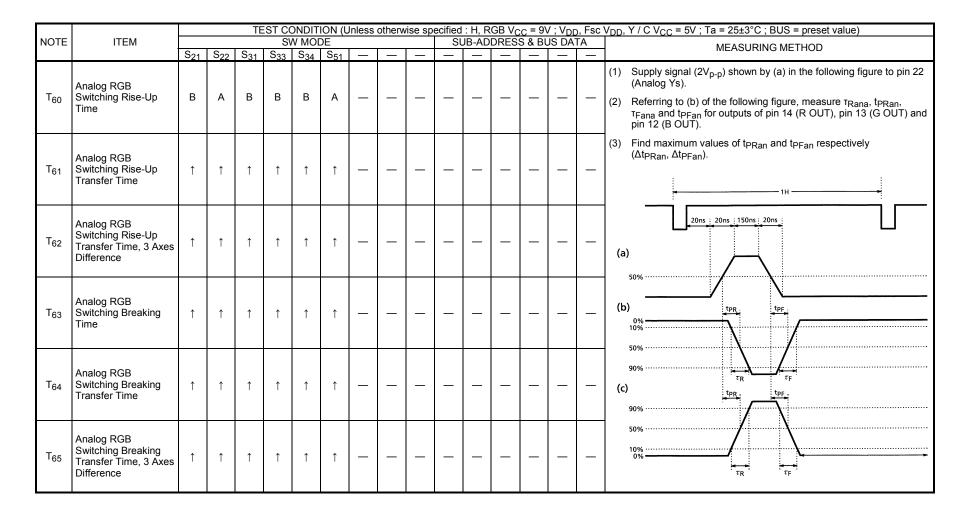
				TE	ST CC	DNDIT	ION (L	Inless	otherw	ise sp	ecified	l : H, R	GB V _C	:C = 9\	/ ; V _{DE}	o, Fsc	V _{DD} , Y / C V _{CC} = 5V ; Ta = 25±3°C ; BUS = preset value)
NOTE	ITEM	C	· ·			V MOI							DRES			TA	MEASURING METHOD
		S ₁₈	519	S ₂₀	S ₂₁	522	S ₃₁	533	S ₃₄	S ₅₁		_	_			_	(1) Supply pin 21 (Digital Ys) with 2.5V.
_	OSD Hi DC Switching					1	_	_	_								(2) Input 5V _{p-p} signal shown by (a) in the figure to pin 18 (Digital R IN).
T ₄₆	Rise-Up Time	Α	Α	Α	Α	В	В	В	В	Α	_	_	_			_	(3) Referring to (b) of the following figure, measure T _{Rosh} , t _{PRoh} , T _{Fosh} and t _{PFoh} for output signal of pin 14 (R OUT).
																	(4) Input 5V _{p-p} signal shown by (a) in the figure to pin 19 (Digital GIN).
T ₄₇	OSD Hi DC Switching Rise-Up Transfer	↑	1	↑	↑	↑	1	1	1	1	_	_	_	_	_	_	(5) Perform the same measurement as the above step 3 for pin 13 output (G OUT) referring to (b) of the following figure.
	Time																(6) Input 5Vp-p signal shown by (a) in the figure to pin 20 (Digital B IN).
	OSD Hi DC Switching																(7) Perform the same measurement as the above step 3 for pin 12 output (B OUT) referring to (b) of the following figure.
T ₄₈	Rise-Up Transfer Time, 3 Axes Difference	↑	1	1	↑	1	1	1	1	1	_	_	_	_	_	_	(8) Find maximum axes differences in t _{PRoh} and t _{PFoh} among the three outputs (Δt _{PRoh} , Δt _{PFoh}).
																	1н —
																	20ns : 20ns : 150ns : 20ns :
T ₄₉	OSD Hi DC Switching Breaking Time	↑	1	1	1	1	1	1	1	1	_	-	_	_	_	_	2018 : 19018 : 2018
																	(a)
	OSD Hi DC Switching																50%
T ₅₀	Breaking Transfer Time	1	1	1	1	1	1	1	1	1	_	_	_	_	_	_	
																	(b) <u>tpr.</u> <u>tpr.</u>
	OSD Hi DC Switching																50%
T ₅₁	Breaking Transfer Time, 3 Axes Difference	1	1	1	↑	1	1	1	1	1	_	_	_	_	_	_	10%
																	rk r

S21 S22 S31 S33 S34 S51 — — — 06H — — — — — — — MEASURING METHOD (1) Input 0.3V synchronizing signal to pin 51 (Sync IN). (2) Supply 5V of external supply voltage to pin 22 (Analog Ys). (3) Set bus data on drive at center value. (4) Input TG7 sine wave signal (f = 100kHz, video amplitude = pin 23 (Analog R IN). (5) While changing data on RGB contrast from maximum (FF) the minimum (00), measure maximum and minimum amplitude amplitude of pin 14 when the bus data is set at the center value. (8) (Vc14mx, Vc14mn, D14c80) (6) In the same manner as the above steps 4 and 5, measure of signal of pin 13 with input of the same external power supply 24 (Analog G IN), and measure output signal of pin 12 with the same power supply to pin 25 (Analog B IN). (Vc12mx, Vc12mx, Vc12mx, Vc14mx, Vc14mx	NOTE			TE						nless	otherw	vise sp							c V _{DD} , Y / C V _{CC} = 5V ; Ta = 25±3°C ; BUS = preset value)
(1) Input 0.3V synchronizing signal to pin 51 (Sync IN). (2) Supply 5V of external supply voltage to pin 22 (Analog Ys). (3) Set bus data on drive at center value. (4) Input TG7 sine wave signal (f = 100kHz, video amplitude = pin 23 (Analog R IN). (5) While changing data on RGB contrast from maximum (FF) the minimum (00), measure maximum and minimum amplitudes 14 (R OUT) in video period. At the same time, measure vide amplitude of pin 14 when the bus data is set at the center video. (Vc14mx, Vc14mn, D14c80) (6) In the same manner as the above steps 4 and 5, measure of signal of pin 13 with input of the same external power suppl 24 (Analog G IN), and measure output signal of pin 12 with the same power supply to pin 25 (Analog B IN). (Vc12mx, V D12c80). (7) Find amplitude ratio between signal with maximum unicolor	NOTE	ı										1			DRES	S & Bl	JS DA	ГА	MEASURING METHOD
RGB output Vcmx (Vcmx+Vcmn)/2 Vcmn	T. RO	RGB Contrast Control		S ₃₁	S1 S ₃₃	SW S ₃₃	SW M03 S34	MODE 34 \$	₹ \$51		—		SU 06H	JB-AD					MEASURING METHOD (1) Input 0.3V synchronizing signal to pin 51 (Sync IN). (2) Supply 5V of external supply voltage to pin 22 (Analog Ys). (3) Set bus data on drive at center value. (4) Input TG7 sine wave signal (f = 100kHz, video amplitude = 0.5V pin 23 (Analog R IN). (5) While changing data on RGB contrast from maximum (FF) to minimum (00), measure maximum and minimum amplitudes of p 14 (R OUT) in video period. At the same time, measure video amplitude of pin 14 when the bus data is set at the center value (80). (Vc14mx, Vc14mn, D14c80) (6) In the same manner as the above steps 4 and 5, measure output signal of pin 13 with input of the same external power supply to 24 (Analog G IN), and measure output signal of pin 12 with input the same power supply to pin 25 (Analog B IN). (Vc12mx, Vc12m D12c80). (7) Find amplitude ratio between signal with maximum unicolor data and signal with minimum unicolor data in conversion into decibe (ΔV13ct).

				TE	EST CO	DNDIT	ION (L	Inless	otherv	vise sp	ecified	: H, R	GB V _C	C = 9\	√; V _{DI}	o, Fsc	V_{DD} , Y / C V_{CC} = 5V ; Ta = 25±3°C ; BUS = preset value)
NOTE	ITEM					N MOI						JB-AD	DRES	S & Bl	JS DA	TA	MEASURING METHOD
		S ₂₁	S_{22}	S ₃₁	S_{33}	S ₃₄	S ₅₁	_	_	_	06H	_	_	_	_	_	MEXICOTATION INC. THOS
T ₅₃	Analog RGB AC Gain	В	А	В	В	В	Α	_	_	_	_	_	_	_	_	_	In the setting condition of the Note T_{52} , calculate output / input gain (double) with contrast data being set maximum. G = Vc13mx / 0.5V
																	(1) Input 0.3V synchronizing signal to pin 51 (Sync IN).
																	(2) Supply 5V of external supply voltage to pin 22 (Analog Ys).
																	(3) Input TG7 sine wave signal (f = 100kHz, video amplitude = 0.5V) to pin 24 (Analog G IN).
T ₅₄	Analog RGB Frequency	↑	1	1	1	1	1	_	_	_	FFH	_	_	_	_	_	(4) Set bus data so that contrast is maximum and drive is set at center value.
	Characteristic																(5) Measure video amplitude of pin 13 (G OUT) and calculate output / input gain (double) (G6M).
																	(6) From measurement results of the above step 5 and the preceding Note 53, find frequency characteristic.
																	Gf = 20log (G6M / G)

TOSHIBA

				TE	ST CC	DNDIT	ION (L	Jnless	otherw	ise sp	ecified	: H, R	GB V _C	_{:C} = 9\	/ ; V _{DE}	, Fsc	۷ _{DD} , ۱	Y / C V _{CC} = 5V ; Ta = 25±3°C ; BUS = preset value)
NOTE	ITEM					N MOI							DRES		JS DA	ГА		MEASURING METHOD
		S ₂₁	S ₂₂	S ₃₁	S ₃₃	S ₃₄	S ₅₁	_	_		01H	06H	_	_	_	_	(4)	least 0.00/ supplies signal to give 54 (Ours INI)
																	(1)	Input 0.3V synchronizing signal to pin 51 (Sync IN).
																	(2)	Supply 5V of external supply voltage to pin 22 (Analog Ys).
T ₅₅	Analog RGB Dynamic	В	Α	В	В	В	A	_	_	_	_	00H	_	_	_	_	` '	Set bus data so that contrast is minimum and drive is set at center value.
	Range																	While inputting stepping signal to pin 24 (Analog G IN), increase video amplitude gradually from 0.
																		Measure video amplitude of pin 24 when video voltage of pin 13 (G OUT) does not change.
											FFH							Short circuit pin 31 (Y IN), pin 33 (B-Y IN) and pin 34 (R-Y IN) in AC coupling.
T ₅₆	RGB Brightness Control Characteristic	1	1	1	1	1	1	_	_	_	00H	_	_	_	_	_	(2)	Input 0.3V synchronizing signal to pin 51 (Sync IN).
											0011						(3)	Set bus data on RGB cutoff at center value.
																	(4)	Supply 5V of external supply voltage to pin 22 (Analog Ys).
T ₅₇	RGB Brightness Center Voltage	↑	1	1	↑	↑	1	_	_	_	80H	_	_	_	_	_	, ,	While changing data brightness from maximum to minimum, measure maximum and minimum voltages of pin 13 (G OUT) in video period. (max: Vbrmx, min: Vbrmn)
																		Set bus data on brightness at center value and measure video voltage of pin 13 (G OUT) (Vbcnt).
T ₅₈	RGB Brightness Data Sensitivity	↑	1	1	1	↑	1	_	_	_	_	_	_	_	_	_		On the condition that bus data with which Vbrmx is obtained in measurement of the above step 5 is Dbrmx and bus data with which Vbrmn is obtained in measurement of the above step 5 is Dbrmn, calculate sensitivity of brightness data (Δ Vbrt).
																		$\Delta Vbrt = (Vbrmx - Vbrmn) / (Dbrmx - Dbrmn)$
																	(1)	Input TG7 sine wave signal (f = 100kHz, video amplitude = 0.3V) to pin 23 (Analog R IN).
T ₅₉	Analog RGB Mode ON Voltage	↑	1	1	1	1	1	_	_	_	80H	_	_	_	_	_		Supply 5V of external supply voltage to pin 22 (Analog Ys) and raise the voltage gradually from 0V.
																		Measure voltage at pin 22 when signal 1 is output from pin 14 (R OUT) (Vanath).



				TE				Jnless	otherw	ise sp							V _{DD}	Y / C V _{CC} = 5V ; Ta = 25±3°C ; BUS = preset value)
NOTE	ITEM	S ₂₁	S ₂₂	S ₃₁		N MOI		I —	Ι	Ι	S	UB-AD	DRES	S & BI	US DA I —	TA T —		MEASURING METHOD
T ₆₆	Analog RGB Hi Switching Rise-Up Time	В	A	В	В	В	A	_	_	_	_	_	_	_	_	_	(1) (2) (3)	(Analog R IN).
	Analog RGB Hi Switching Rise-Up Transfer Time	1	1	1	1	1	1	_	_	_	_	_	_	_	_	_	(4) (5) (6)	(Analog G IN). Referring to (b) of the following figure, perform the same measurement as the above step 3 for output of pin 13 (G OUT).
T ₆₈	Analog RGB Hi Switching Rise-Up Transfer Time, 3 Axes Difference	1	1	1	1	1	1	_	_	_	_					_	(7)	Referring to (b) of the following figure, perform the same measurement as the above step 3 for output of pin 12 (B OUT).
T ₆₉	Analog RGB Hi Switching Breaking Time	1	1	1	1	1	1	_	_	_	_	_	_	_	_	-	(a)	20ns : 20ns : 150ns : 20ns
T ₇₀	Analog RGB Hi Switching Breaking Transfer Time	1	1	1	1	1	1	_	_	_	_	_	_	_	_	_	(b)	
T ₇₁	Analog RGB Hi Switching Breaking Transfer Time, 3 Axes Difference	1	1	1	1	1	1	_	_	_	_	_	_	_	_	_		90% 50% 10% 0%

				TE	ST CO	TIDNC	ION (L	Inless	otherw	ise sp	ecified	: H, R	GB V _C	;C = 9\	√; V _{DI}	o, Fsc	: V _{DD}	, Y / C V _{CC} = 5V ; Ta = 25±3°C ; BUS = preset value)
NOTE	ITEM	S	S ₂₂	S ₃₁	S ₃₃	N MOI S ₃₄		l			SL	JB-AD	DRES	S & BL	JS DA	TA		MEASURING METHOD
		321	322	331	033	334	351									_	(1)	Input TG7 sine wave signal (f = 4MHz, video amplitude = 0.5V) to pin 31 (Y ₂ IN).
																	(2)	Short circuit pin 25 (Analog G IN) in AC coupling.
																	(3)	Input 0.3V synchronizing signal to pin 51 (Sync IN).
																	(4)	Set bus data so that contrast is maximum, Y sub contrast and drive are set at center value.
T ₇₂	TV-Analog RGB Crosstalk	В	Α	В	В	В	Α	_	_	_	_	_	_	_	_	_	(5)	Supply pin 22 (Analog Ys) with 0V of external power supply.
	Ciossiaik																(6)	Measure video voltage of output signal of pin 13 (G OUT) (Vtg).
																	(7)	Supply pin 22 (Analog Ys) with 2V of external power supply.
																	(8)	Measure video voltage of output signal of pin 13 (G OUT) (Vana).
																	(9)	From measurement results of the above steps 5 and 7, calculate crosstalk from TV to analog RGB.
																		Crtva = 20log (Vana / Vtv)
																	(1)	Short circuit pin 31 (Y $_2$ IN), pin 34 (R-Y IN) and pin33 (B-Y IN) in AC coupling.
																	(2)	Input 0.3V synchronizing signal to pin 51 (Sync IN).
																	(3)	Set bus data so that contrast is maximum and drive is set at center value.
																	(4)	Input TG7 sine wave signal (f = 4MHz, video amplitude = $0.5V$) to pin 24 (Analog G IN).
T ₇₃	Analog RGB-TV Crosstalk	1	1	1	1	1	1	_	_	_	_	_	_	_	_	_	(5)	Supply pin 22 (Analog Ys) with 0V of external power supply.
																	(6)	Measure video voltage of output signal of pin 13 (G OUT) (Vant).
																	(7)	Supply pin 22 (Analog Ys) with 2V of external power supply.
																	(8)	Measure video voltage of output signal of pin 13 (G OUT) (Vtan).
																	(9)	From measurement results of the above steps 6 and 8, calculate crosstalk from analog RGB to TV.
																		Crant = 20log (Vant / Vtan)

				TE				Inless	otherw	ise sp							V_{DD}	, Y / C V _{CC} = 5V ; Ta = 25±3°C ; BUS = preset value)
NOTE	ITEM	S ₂₁	Soc	S ₃₁		V MOI S ₃₄		l	г_	г		JB-AD 15H		S & BL	JS DA	TA		MEASURING METHOD
T ₇₄	ABL Point Characteristic	B	В	B	В	В	A	_	_	_	FFH	10H	_	_	_	-	(2)	Input TG7 sine wave signal (f = 4MHz, video amplitude = 0.5V) to pin 31 (Y ₂ IN). Short circuit pin 23 (Analog R IN), pin 25 (Analog G IN) and pin 26 (Analog B IN) in AC coupling. Set bus data so that brightness is maximum and ABL gain is at center value, and supply pin 16 with external supply voltage. While turning down voltage supplied to pin 16 gradually from 7V, measure voltage at pin16 when the voltage supplied to pin 12 decreases by 0.3V in three conditions that data on ABL point is set at minimum, center and maximum values respectively. (Vablpl, Vablpc, Vablph)
T ₇₅	ACL Characteristic	1	1	1	1	1	1	_	_	_	_	_	_	_	_	_	(2) (3) (4) (5)	Input TG7 sine wave signal (f = 4MHz, video amplitude = 0.5V) to pin 31 (Y ₂ IN). Input 0.3V synchronizing signal to pin 51 (Sync IN). Measure video amplitude at pin 12. (Vacl1) Measure DC voltage at pin 16 (ABCL). Supply pin 16 with a voltage that the voltage measured in the above step 4 minus 2V. Measure video amplitude at pin 12 (Vacl2) and its ratio to the amplitude measured in the above step 3. Vacl = 20log (Vacl2 / Vacl1)
T ₇₆	ABL Gain Characteristic	1	1	↑	↑	1	î	_	_	_	FFH	00H 10H 1CH	_	_	_	I	(2) (3) (4) (5)	Short circuit pin 31 (Y ₂ IN), pin 34 (R-Y IN) and pin 33 (B-Y IN) in AC coupling. Input 0.3V synchronizing signal to pin 51 (Sync IN). Set bus data on brightness at maximum and measure video DC voltage at pin 12 (Vmax). Measure voltage at pin 16 which is being supplied with the voltage measured in the step 5 of the preceding Note 75. Changing setting of bus data on ABL gain at minimum, center and maximum values one after another, measure video DC voltage at pin 12. (VabI1, VabI2, VabI3) Find respective differences of VabI1, VabI2 and VabI3 from the voltage measured in the above step 3. VabII = Vmax - VabI1 VabIc = Vmax - VabI2 VabIh = Vmax - VabI3

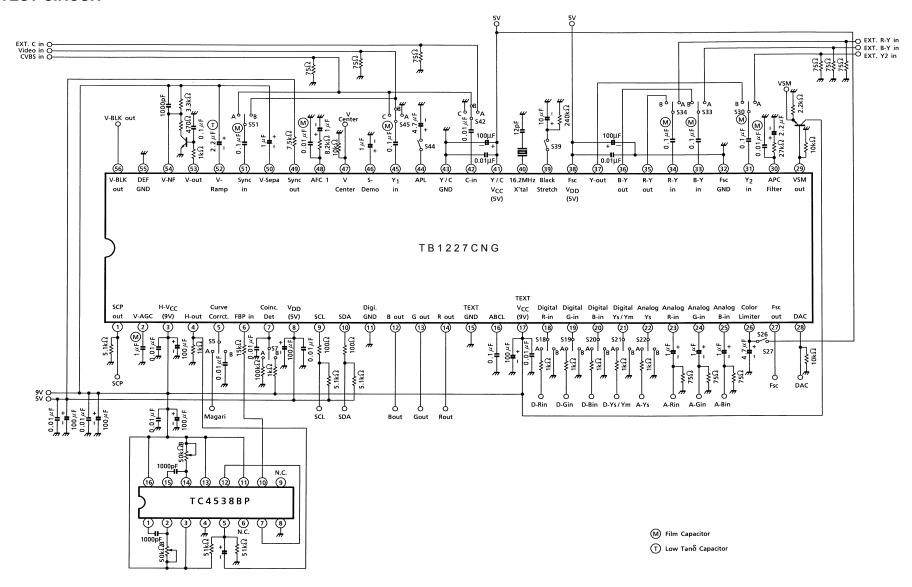
SECAM SECTION

							TF	STC	OND	ITION	N (Ur	iless	othei	rwise	spe	cified	I · Н	RGB	Vcc	· = 9\	/ · V	on F	sc Vn	- Y/(C Vcc =	= 5V ; Ta = 25±3°C)
NOTE	ITEM	s		BUS	: TE	ST M	1ODE	:			. ,0.		Bl	JS : I	NOR	MAL	CON	ITRO	L M	ODE	· , • [י, יטי, י	• D	<i>J</i> , . , ,	1	· , · · · · · · · · · · · · · · · · · ·
NOTE	I I EIVI	5	1 02H 07H 0										10H								1FH				MEASURING METHOD	
		26	D_4	D_3	D_2	D_7	D_5	D_4	D_4	D_7	D_5	D_4	D_3	D_2	D_1	D_0	D_7	D_6	D_5	D_4	D_3	D_2	D_1	D ₀		
S ₁	Bell Monitor Output Amplitude	ON	0	1	0	0	0	0	1	0	0	0	0	0	0	0	1	0	0	0	0	0	0	1	(2) N	Input 200mV _{p-p} (R-Y ID), 75% chroma color bar signal (SECAM system) to pin 42. Measure amplitude of R-Y ID output of pin 36 as ebmo.
S ₂	Bell Filter f _o	1	1	1	1	1	1	†	↑	1	1	1	1	1	1	1	1	1	1	↑	↑	↑	1	↑	fr o a g	While supplying 20mV _{p-p} CW sweep signal from network analyzer to pin 42 and monitoring output signal of pin 36 with the network analyzer, measure frequency having maximum gain as foBEL of the bell frequency characteristic.
																										Find difference between foBEL and 4.286MHz as foB-C.
																										The same procedure as the steps 1 and 2 of the Note S_2 .
S ₃	Bell Filter f _o Variable Range	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	Vari- able	Vari- able	(I e	Measure foBEL in different condition that SUB (IF) D_1D_0 = (00) or (11), and find difference of each measurement result from 4.286MHz as foB-L or foB-H.
																										The same procedure as the step 1 of the Note S_2 .
S ₄	Bell Filter Q	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	0	1) n	While monitoring output signal of pin 36 with network analyzer, measure Q of bell frequency characteristic as QBEL. QBEL = (QMAX -3dB band width) / FoBEL
S ₅	Color Difference Output Amplitude	OFF	_	_	_	_	_	_	0	1	1	1	1	1	1	1	1	1	1	1	1	↑	↑	1		Input 200mV _{p-p} (R-Y ID), 75% chroma color bar signal (SECAM system) to pin 42.
S ₆	Color Difference Relative Amplitude	1	_	_	_	_	_	_	1	1	1	1	1	1	1	1	1	1	1	1	1	1	↑	1) w	Measure color difference levels VRS and VBS with signals of pin 35 and pin 36.
	Relative Amplitude								·													·	,	·	(3) C	Calculate relative amplitude from VRS / VBS.

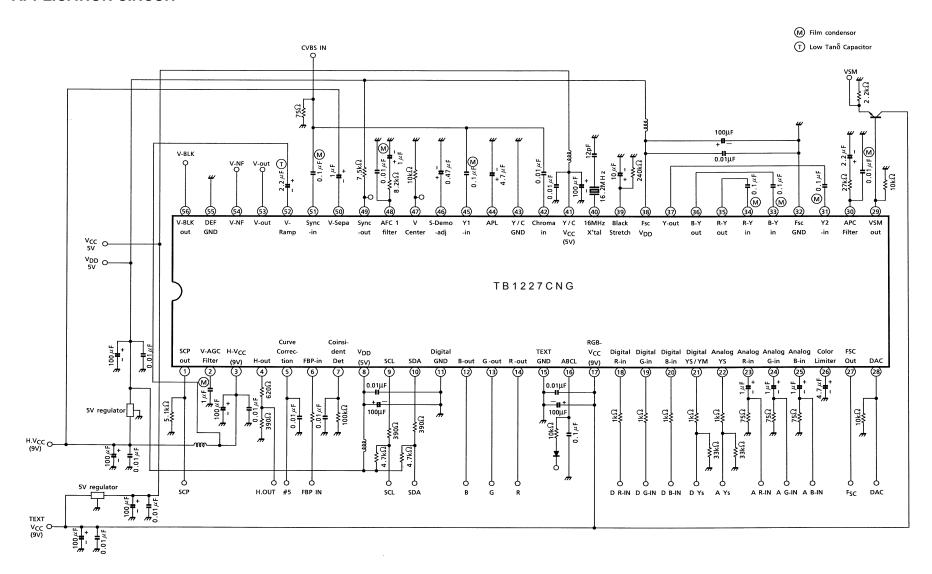
							TE	ST C	ONDI	TION	l (Un	less	other	wise	spec	cified	: H,	RGB	Vcc	= 9\	/ ; V _[op, F	sc V	_{DD} , Y	Y / C V _{CC} = 5V ; Ta = 25±3°C)	
NOTE	ITEM	S		BUS	: TES		IODE						BUS	3 : N	ORM	AL C	ONT	ROL	MO	DE					MEAGURING METUOR	
		26		02H 07H 04 D3 D2 D7 D5			In.	0FH		D-	Δ.	10H		Π.	η.	D-	ρ.	η-	1F		η.	Г.	Π.	MEASURING METHOD		
		20	υ4	D3	D ₂	υ ₇	D5	υ4	D ₄	Dγ	D5	υ4	D3	D ₂	D ₁	D0	Dγ	D ₆	D5	υ4	D3	D ₂	D1	D ₀	(1) The same procedure as the steps 1 and 2 of the Note S ₅ .	
S ₇	Color Difference Attenuation Quantity	OFF	_	_	_	_	_	_	0	0	0	0	0	0	0	0	1	1	0	0	0	0	0	1	(2) In the condition that SUB (IF) D ₆ = 1, measure amplitudes of color difference signals of pin 35 and pin36 as VRSA and VBSA respectively, and find SATTR and SATTB from measurement results.	
																									SATTR = 20log (VRSA / VRS),	
																									SATTB = 20log (VBSA / VBS)	
																									(1) The same procedure as the steps 1 and 2 of the Note S_5 .	
	Color Difference S / N Ratio																								(2) Input non-modulated 200V _{p-p} (R-Y) chroma signal to pin 42.	
S ₈		1	_	_	_	_	_	_	1	1	1	↑	1	1	1	1	1	0	1	1	1	1	1	1	(3) Measure noise amplitude nR and nB (mV _{p-p}) appearing in color difference signals of pin 35 and pin 36 respectively.	
																									(4) Find S / N ratio by the following equation.	
																									$SNB-S = 20 log (2\sqrt{2} \times VBS / nB \times 10E - 3)$	
																									$SNR - S = 20 log (2\sqrt{2} \times VRS / nR \times 10E - 3)$	
																									(1) The same procedure as the step 1 of the Note S ₅ .	
																									(2) Measure and calculate amplitude of black bar levels in output waveforms of pin 35 and pin 36 as shown below.	
S ₉	Linearity	1	-	-	_	_	_	_	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	LinB = V [cyan] / V [red]	
																									Maximum positive / negative amplitudes in respective axes	
																									LinR = V [yellow] / V [blue]	

							TE	ST C	ONDI	TION	l (Un	less	other	wise	spe	cified	: H,	RGB	Vcc	= 9\	/ ; V _[DD, F	sc V	DD, Y	/CV _{CC} =	= 5V ; Ta = 25±3°C)
NOTE	TE ITEM S BUS : TEST MODE BUS : NORMAL CONTROL MODE 15H 15H																									
		26		02H			07H D ₇ D ₅ D ₄			D-	n-	In.	10H		I D.	D.	D-	l Da	n-			D.	ln.	l n.	MEASURING METHOD	
		20	υ4	D3	υ2	Dγ	υ5	υ4	υ4	Dγ	D5	υ4	D3	D ₂	ᄓ	υ0	Dγ	D ₆	D5	υ4	DЗ	υ2	ν1	υ0	(1) The	same procedure as the step 1 of the Note S ₅ .
S ₁₀	Rising-Fall Time (Standard De-Emphasis)	OFF	_	_	_	_	_		0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	1	(2) Mea	sure output waveforms of pin 35 and pin 36 and the period between the two points shown in figure in time. Magenta
																										/
S ₁₁	Rising-Fall Time (Wide-Band De-Emphasis)	1	_	_	_	_	_		↑	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	` same	t _{rfB} , t _{rfR} Green e condition that SUB (IF) D ₅ = 1, perform the e measurement as the above step 2. surement results are expressed as t _{rfBW} and y.
S ₁₂	Killer Operation Input Level (Standard Setting)	1	_	_	_	_	_	_	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	signa (2) Atter ID si	t 200mV _{p-p} (R-Y ID) standard 75% color bar al (SECAM system) to pin 42. nuate the input signal to pin 42. Measure R-Y ignal level at pin 42 that turns on / off the killer
S ₁₃	Killer Operation Input Level (VID ON)	1	_	_	_	_	_	_	1	1	1	1	1	1	1	1	1	1	0	1	1	1	1	1	(3) In the	SK and eSC. e condition that SUB (IF) D ₃ = 1, perform the e measurement as the above step 2 and ess the measurement results as eSFK and C.
S ₁₄	Killer Operation Input Level (Low Sensitivity, VID OFF)	1	_	_	_	_	_	_	1	1	1	1	1	1	1	1	1	1	1	1	0	1	1	1	perfo step	be condition that SUB (IF) $D_3 = 0$, $D_2 = 1$, form the same measurement as the above 2 and express the measurement results as /K and eSWC.

TEST CIRCUIT



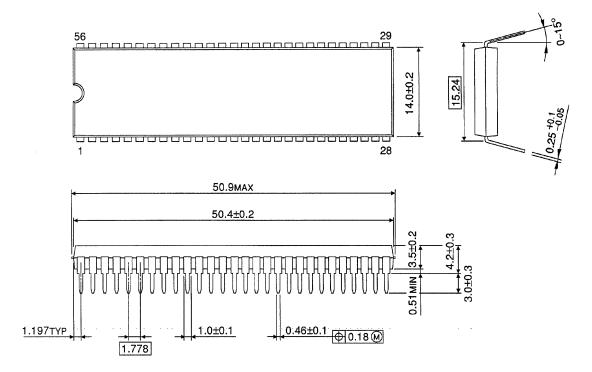
APPLICATION CIRCUIT



Unit: mm

PACKAGE DIMENSIONS

SDIP56-P-600-1.78



Weight: 5.55g (Typ.)

About solderability, following conditions were confirmed

- Solderability
 - (1) Use of Sn-63Pb solder Bath
 - solder bath temperature = 230°C
 - · dipping time = 5 seconds
 - · the number of times = once
 - · use of R-type flux
 - (2) Use of Sn-3.0Ag-0.5Cu solder Bath
 - solder bath temperature = 245°C
 - · dipping time = 5 seconds
 - · the number of times = once
 - · use of R-type flux

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030619EBA

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